SSD1926

Advance Information

JPEG Coder
SD interface
256K Embedded Display SRAM
Image Processor
CMOS

1   GENERAL DESCRIPTION

SSD1926 is an image processor designed for advanced car AV device with image capture and process features.

The image files can be saved into SD/MMC card through SD interface. The JPEG file is retrieved back from SD/MMC card, decoded and displayed on LCD panel through LCD interface. This interface supports various kinds of LCD panel like STN, CSTN and TFT.

The LCD controller of SSD1926 supports LCD panel for mobile phone with size, for example, 176x220 and 240x160 resolution at color depth 1, 2, 4, 8, 16 and 32 bit-per-pixel (bpp). For 16 and 32 bpp, SSD1926 provides 2D graphics acceleration features like virtual display, image rotation, cursor display, line drawing, BitBLT with raster operation, color fill, color expansion etc.

SSD1926 is able to interface different type of generic microcontrollers that are popular in handheld devices market. It also support indirect addressing mode which can minimize the pin count of control signals.

Internal PLLs is built such that only single clock is required for SSD1926 to generate clocks for blocks with various clock speed requirement.

With advanced power management design, SSD1926 is suitable for low power consumption and advanced image applications etc. The SSD1926 is available in LQFP package.

2   FEATURES

The main features of the SSD1926 are as follows:

2.1   Hardware JPEG decoder

- Hardware decoder to decode JPEG image with variable size up to 1280 x 1024.

- JPEG decoder is consisted of the following hardware module
    a. Discrete Cosine Transform (DCT) and Inverse Discrete Cosine Transform (iDCT)
    b. Quantization calculation with table downloadable by software
    c. Zigzag and run-length coding
    d. Huffman decoding with table downloadable by software

- For viewing JPEG image on LCD panel, the JPEG decoder can decimate and crop the image such that the length is in multiple of 8.

2.2   2D Graphic Engine

- Screen panning and scrolling – virtual display mode

- Image rotation including 0, 90, 180, 270 degree

- Two cursors with three colors and transparency selection. Cursor blinking is available

- Line drawing

- Rectangle drawing

- Ellipse drawing

- Bit block transfer (BitBLT)
    a. Host to frame buffer
    b. Frame buffer to frame buffer
    c. Total 256 three-operand raster operations (ROP3) working with BitBLT
    d. Pattern BitBLT: Source image is repeatedly filled up destination block
    e. Stretch BitBLT: Stretch the source image to a destination larger or smaller than the source
    f. Color Expansion: Monochrome color is expanded to either background or foreground color.
    g. Color Fill: Fill a rectangular block with a single color.

2.3 LCD Graphic Controller

- Support 1, 2, 4, 8, 16 and 32 bit-per-pixel (bpp) color depth

- In 32bpp mode, each pixel is consisted of 8-bit red, 8-bit green, 8-bit blue and 8-bit alpha channel for controlling the transparency of the image.

- In 1, 2, 4, 8bpp mode, it can display still image and has no 2D graphic engine feature available.

- Arbitrary image size supported up to horizontal resolution of 512

2.4 LCD Panel Interface

- Support the following type of LCD panels:
    a. Monochrome and color STN 4/8/12/16 bit interface
    b. TFT 9/12/18/24 bit interface
    c. 18 bit HR-TFT interface
    d. 8 bit Serial TFT interface
    e. 8 bit Delta panel with sub-pixel accuracy algorithm
    f. Support Smart LCD panels through SPI and 8-bit MCU (8080, 6800) interface

- For STN and CSTN panel, spatial and dynamic dithering is available to increase color depth.
    a. 16 gray shades for each color component when applying frame rate control only
    b. 64 gray shades for each color component when applying frame rate control and dithering

- LCD panel power on and off sequencing

2.5 Host MCU interface

- Support the following MCU interface
    a. SRAM interface (e.g. generic ARM core type MCU)
    b. ISA interface for MCU like NEC MIPS
    c. 8/16 bits 8080 indirect addressing mode

- Support synchronous and asynchronous interface communication

- Memory mapped I/O

- Big/Little endian support

2.6 MMC/SD Interface

- Compatible with "The MultiMedia Card System Specification version 3.0"

- Compatible with "SD Memory Card Specification version 1.0" and "SDIO Card Specification version 1.0"

- Block transfer from/to external host

- Block transfer from/to internal memory

- Supports many SD functions including multiple I/O and combined I/O and memory

2.7 I/O Interface
- 13 GPIOs

2.8 Miscellaneous
- Embedded 256K bytes SRAM

- Single clock input

- Integrated PLL

- Advanced power management to cut off the power for modules that are idle.
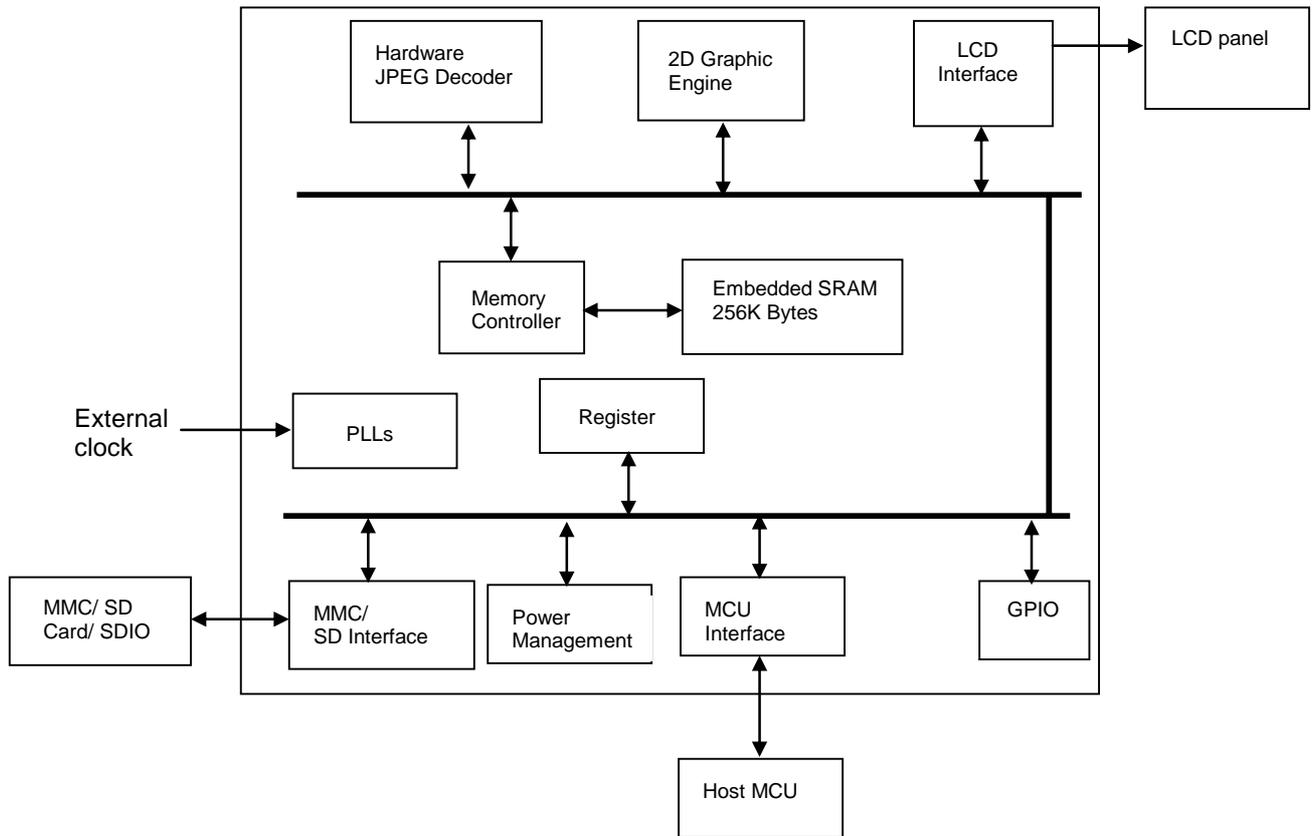
2.9 Package
- 128-pin LQFP package

3 ORDERING INFORMATION

Table 3-1 : Ordering Information

Ordering Part Number	Package Form
SSD1926QL9	128 LQFP

4 BLOCK DIAGRAM

Figure 4-1 : SSD1926 Block Diagram

5 PIN ARRANGEMENT

5.1 128 pin LQFP

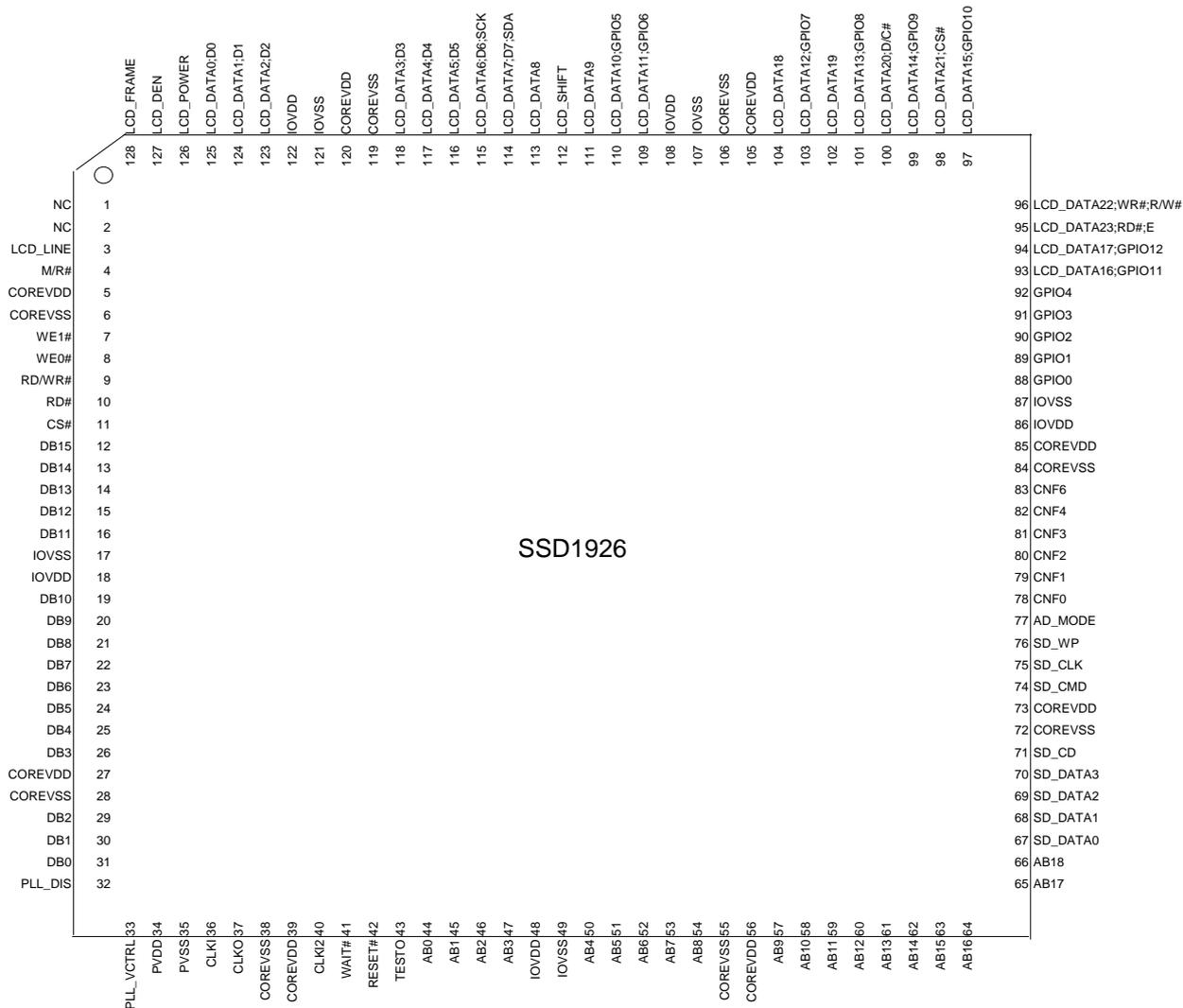**Figure 5-1 : Pinout Diagram – 128 pin LQFP (Topview)**

SSD1926

Top pins (left to right, 128–97):

Pin	Signal
128	LCD_FRAME
127	LCD_DEN
126	LCD_POWER
125	LCD_DATA0;D0
124	LCD_DATA1;D1
123	LCD_DATA2;D2
122	IOVDD
121	IOVSS
120	COREVDD
119	COREVSS
118	LCD_DATA3;D3
117	LCD_DATA4;D4
116	LCD_DATA5;D5
115	LCD_DATA6;D6;SCK
114	LCD_DATA7;D7;SDA
113	LCD_DATA8
112	LCD_SHIFT
111	LCD_DATA9
110	LCD_DATA10;GPIO5
109	LCD_DATA11;GPIO6
108	IOVDD
107	IOVSS
106	COREVSS
105	COREVDD
104	LCD_DATA18
103	LCD_DATA12;GPIO7
102	LCD_DATA19
101	LCD_DATA13;GPIO8
100	LCD_DATA20;D/C#
99	LCD_DATA14;GPIO9
98	LCD_DATA21;CS#
97	LCD_DATA15;GPIO10

Left pins (top to bottom, 1–32):

Pin	Signal
1	NC
2	NC
3	LCD_LINE
4	M/R#
5	COREVDD
6	COREVSS
7	WE1#
8	WE0#
9	RD/WR#
10	RD#
11	CS#
12	DB15
13	DB14
14	DB13
15	DB12
16	DB11
17	IOVSS
18	IOVDD
19	DB10
20	DB9
21	DB8
22	DB7
23	DB6
24	DB5
25	DB4
26	DB3
27	COREVDD
28	COREVSS
29	DB2
30	DB1
31	DB0
32	PLL_DIS

Right pins (top to bottom, 96–65):

Pin	Signal
96	LCD_DATA22;WR#;R/W#
95	LCD_DATA23;RD#;E
94	LCD_DATA17;GPIO12
93	LCD_DATA16;GPIO11
92	GPIO4
91	GPIO3
90	GPIO2
89	GPIO1
88	GPIO0
87	IOVSS
86	IOVDD
85	COREVDD
84	COREVSS
83	CNF6
82	CNF4
81	CNF3
80	CNF2
79	CNF1
78	CNF0
77	AD_MODE
76	SD_WP
75	SD_CLK
74	SD_CMD
73	COREVDD
72	COREVSS
71	SD_CD
70	SD_DATA3
69	SD_DATA2
68	SD_DATA1
67	SD_DATA0
66	AB18
65	AB17

Bottom pins (left to right, 33–64):

Pin	Signal
33	PLL_VCTRL
34	PVDD
35	PVSS
36	CLKI
37	CLKO
38	COREVSS
39	COREVDD
40	CLKI2
41	WAIT#
42	RESET#
43	TESTO
44	AB0
45	AB1
46	AB2
47	AB3
48	IOVDD
49	IOVSS
50	AB4
51	AB5
52	AB6
53	AB7
54	AB8
55	COREVSS
56	COREVDD
57	AB9
58	AB10
59	AB11
60	AB12
61	AB13
62	AB14
63	AB15
64	AB16

Table 5-1 : LQFP Pin Assignment Table

Pin #	Signal Name	Pin #	Signal Name	Pin #	Signal Name	Pin #	Signal Name
1	NC	33	PLL_VCTRL	65	AB17	97	LCD_DATA15; GPIO10
2	NC	34	PV_{DD}	66	AB18	98	LCD_DATA21; CS#
3	LCD_LINE	35	PV_{SS}	67	SD_DATA0	99	LCD_DATA14; GPIO9
4	M/R#	36	CLKI	68	SD_DATA1	100	LCD_DATA20; D/C#
5	$COREV_{DD}$	37	CLKO	69	SD_DATA2	101	LCD_DATA13; GPIO8
6	$COREV_{SS}$	38	$COREV_{SS}$	70	SD_DATA3	102	LCD_DATA19
7	WE1#	39	$COREV_{DD}$	71	SD_CD	103	LCD_DATA12; GPIO7
8	WE0#	40	CLKI2	72	$COREV_{SS}$	104	LCD_DATA18
9	RD/WR#	41	WAIT#	73	$COREV_{DD}$	105	$COREV_{DD}$
10	RD#	42	RESET#	74	SD_CMD	106	$COREV_{SS}$
11	CS#	43	TESTO	75	SD_CLK	107	IOV_{SS}
12	DB15	44	AB0	76	SD_WP	108	IOV_{DD}
13	DB14	45	AB1	77	AD_MODE	109	LC_DATA11; GPIO6
14	DB13	46	AB2	78	CNF0	110	LCD_DATA10; GPIO5
15	DB12	47	AB3	79	CNF1	111	LCD_DATA9
16	DB11	48	IOV_{DD}	80	CNF2	112	LCD_SHIFT
17	IOV_{SS}	49	IOV_{SS}	81	CNF3	113	LCD_DATA8
18	IOV_{DD}	50	AB4	82	CNF4	114	LCD_DATA7;D7; SDA
19	DB10	51	AB5	83	CNF6	115	LCD_DATA6;D6; SCK
20	DB9	52	AB6	84	$COREV_{SS}$	116	LCD_DATA5;D5
21	DB8	53	AB7	85	$COREV_{DD}$	117	LCD_DATA4;D4
22	DB7	54	AB8	86	IOV_{DD}	118	LCD_DATA3;D3
23	DB6	55	$COREV_{SS}$	87	IOV_{SS}	119	$COREV_{SS}$
24	DB5	56	$COREV_{DD}$	88	GPIO0	120	$COREV_{DD}$
25	DB4	57	AB9	89	GPIO1	121	IOV_{SS}
26	DB3	58	AB10	90	GPIO2	122	IOV_{DD}
27	$COREV_{DD}$	59	AB11	91	GPIO3	123	LCD_DATA2;D2
28	$COREV_{SS}$	60	AB12	92	GPIO4	124	LCD_DATA1;D1
29	DB2	61	AB13	93	LCD_DATA16; GPIO11	125	LCD_DATA0;D0
30	DB1	62	AB14	94	LCD_DATA17; GPIO12	126	LCD_POWER
31	DB0	63	AB15	95	LCD_DATA23; RD#;E	127	LCD_DEN
32	PLL_DIS	64	AB16	96	LC_DATA22; WR#;R/W#	128	LCD_FRAME

6   PIN DESCRIPTIONS

Key:

I = Input
O =Output
IO = Bi-directional (input / output)
P = Power pin
AN = Analog
LIS = LVCMOS Schmitt input
LB2 = LVCMOS IO buffer (8mA/-8mA at 3.3V)
LB3 = LVCMOS IO buffer (16mA/-16mA at 3.3V)
LO1 = LVCMOS output buffer (2mA/-2mA at 3.3V)
LO2 = LVCMOS output buffer (4mA/-4mA at 3.3V)
LO3 = LVCMOS output buffer (16mA/-16mA at 3.3V)
LT2 = Tri-state output buffer (8mA/-8mA at 3.3V)
Hi-Z = High impedance

6.1   Global Signal

Table 6-1 : Host Interface Pin Descriptions

Pin Name	Type	LQFP Pin #	Cell	RESET# State	Description
CLKI2	I	40	LIS	-	This pin can used as clock source input when PLL is disable. When synchronized MCU interface is selected, connect the bus clock to CLKI2 and disable the PLL by connecting the PLL_DIS pin to IOV_{DD}. If the PLL is enabled. CLKI2 has to be pull-up or pull-down.
CLKI, CLKO	IO	36, 37	AN	-	These two pins are the source clock of internal PLL. It accepts clock frequency from 2MHz to 4MHz. The clock source can be either oscillator or crystal. If 4-pin oscillator or a slow clock source is available, please connect the output of oscillator or the clock source to CLKI and leave the CLKO pin floating. If CLKI2 is used as clock source, CLKI has to be pull-up or pull down and leave CLKO floating.
PLL_DIS	I	32	LIS	-	PLL disable control pin. PLL_DIS = IOV_{DD}, PLL disabled (When PLL is disable, the master clock is directly fed from CLKI2 pin) PLL_DIS = IOV_{SS}, PLL enabled
PLL_VCTRL	I	33	AN	-	Control for PLL. If internal PLL is selected, RC circuit should be connected. Refer to 7.1. Leave this pin floating if PLL is disabled.
RESET#	I	42	LIS	-	Master chip reset. Active low input to set all internal registers to the default state and to force all signals to their inactive states. It is recommended to place a 0.1μF capacitor to V_{SS}. **Note** [1] When reset state is released (RESET# = "H"), normal operation can be started after 3 MCLK period.

6.2   MCU Interface

Table 6-2 : MCU Interface Pin Descriptions

Pin Name	Type	LQFP Pin #	Cell	RESET# State	Description
AB0	I	44	LIS	0	This input pin has multiple functions. • For Generic #1, this pin is not used and should be connected to V_{SS}. • For Generic #2, this is an input of system address bit 0 (A0). • For 8080, this pin is not used and should be connected to V_{SS}.
AB[18:4, 2, 1]	I	45-46, 50-54, 57-66	LIS	0	System address bus bits 18-4, 2, 1 for direct address mode. For 8080, those pins are not used and should be connected to V_{SS}.
AB[3]	I	47	LIS	0	This input pin has multiple functions. • System address bus bit 3 for direct address mode • For 8080, this pin is used as data / command select, D/C#.
DB[15:0]	IO	12-16, 19-26, 29-31	LB2	Hi-Z	Bi-directional system data bus 15:0.
WE0#	I	8	LIS	1	This input pin has multiple functions. • For Generic #1, this is an input of the write enable signal for the lower data byte (WE0#). • For Generic #2, this is an input of the write enable signal (WE#). • For 8080, this is an input of write enable signal, WR#
WE1#	I	7	LIS	1	This input pin has multiple functions. • For Generic #1, this is an input of the write enable signal for the upper data byte (WE1#). • For Generic #2, this is an input of the byte enable signal for the high data byte (BHE#). • For 8080, this pin is not used and should be connected to V_{SS}.
CS#	I	11	LIS	1	Chip select input.
M/R#	I	4	LIS	0	• For 8080, this pin is not used and should be connected to V_{SS}. • For other interfaces, this input pin is used to select the display buffer or internal registers of the SSD1926. M/R# is set high to access the display buffer and low to access the registers.
RD/WR#	I	9	LIS	1	This input pin has multiple functions. • For Generic #1, this is an input of the read signal for the upper data byte (RD1#). • For Generic #2, this pin must be tied to IOV_{DD}. • For 8080, this pin is not used and should be connected to VSS.

Pin Name	Type	LQFP Pin #	Cell	RESET# State	Description
RD#	I	10	LIS	1	This input pin has multiple functions. • For Generic #1, this is an input of the read signal for the lower data byte (RD0#). • For Generic #2, this is an input of the read command (RD#). • For 8080, this is an input of read enable signal, RD#
WAIT#	O	41	LT2	Hi-Z	During a data transfer, this output pin is driven active to force the system to insert wait states. It is driven inactive to indicate the completion of a data transfer. WAIT# is released to the high impedance state after the data transfer is complete. Its active polarity is configurable. A pull-up or pull-down resistor should be used to resolve any data contention issues. See Table 6-8 : Summary of Configuration . • For Generic #1, this pin outputs the wait signal (WAIT#). • For Generic #2, this pin outputs the wait signal (WAIT#). • For 8080, this pin outputs the wait signal (WAIT#).

See Table 6-9 : Host Bus Interface Pin Mapping for summary.

6.3 Display Interface

Table 6-3 : Display Interface Pin Descriptions

Pin Name	Type	LQFP Pin #	Cell	RESET# State	Description
LCD_DATA[5:0];D[5:0]	O	116-118,123-125	LO3	0	If RGB dump panel is selected, those pins are RGB dump data bits 5-0. If MCU smart parallel panel is selected, those pins are data bits 5-0 If MCU smart serial panel is selected, those signals are not in used.
LCD_DATA6;D6;SCK	O	115	LO3	0	If RGB dump panel is selected, this pin is RGB dump data bit 6. If MCU smart parallel panel is selected, this pin is data bit 6 If MCU smart serial panel is selected, this pin becomes serial clock signal, SCK.
LCD_DATA7;D7;SDA	O	114	LO3	0	If RGB dump panel is selected, this pin is RGB dump data bit 7. If MCU smart parallel panel is selected, this pin is data bit 7 If MCU smart serial panel is selected, this pin becomes serial data signal, SDA.
LCD_DATA8;D8	O	113	LO3	0	If RGB dump panel is selected, RGB dump data bits 8 If MCU smart parallel panel is selected, data bits 8 If MCU smart serial panel is selected, this signal is not in used.
LCD_DATA9	O	111	LO3	0	If RGB dump panel is selected, RGB dump data bit 9 If MCU smart panel is selected, those signals were not in used.

LCD_DATA[17:10]; GPIO[12:5]	IO	93,94,97,99, 101,103,109 ,110	LB3	0	If 18/24-bit dump TFT panel is selected, RGB dump data bits 17:10 If other dump and MCU smart panel is selected, these pins become GPIO control pins.
LCD_DATA[19:18]	O	102,104	LO3	0	If RGB dump panel is selected, RGB dump data bits 19,18 If MCU smart panel is selected, those signals were not in used.
LCD_DATA20; D/C#	O	100	LO3	0	If RGB dump panel is selected, RGB dump data bits 20 If MCU smart parallel or serial panel is selected, this signal is data/command select, D/C#.
LCD_DATA21;CS#	O	98	LO3	0	If RGB dump panel is selected, RGB dump data bits 21 If MCU smart parallel or serial panel is selected, this signal is chip select, CS#.
LCD_DATA22;WR#; R/W#	O	96	LO3	0	If RGB dump panel is selected, RGB dump data bits 22 If MCU smart parallel 8080 panel is selected, this signal is WR#. If MCU smart parallel 6800 panel is selected, this signal is R/W#. If MCU smart serial panel is selected, this signal is not in used.
LCD_DATA23;RD#; E	O	95	LO3	0	If RGB dump panel is selected, RGB dump data bits 23 If MCU smart parallel 8080 panel is selected, this signal is RD#. If MCU smart parallel 6800 panel is selected, this signal is E. If MCU smart serial panel is selected, this signal is not in used.
LCD_FRAME	O	128	LO3	0	Frame Pulse (vertical sync)
LCD_LINE	O	3	LO3	0	Line Pulse (horizontal sync)
LCD_SHIFT	O	112	LO3	0	Shift Clock
LCD_DEN	O	127	LO3	0	This output pin has multiple functions. • Display enable (LDEN) for TFT panels • LCD backplane bias signal (MOD) for all other LCD panels
LPOWER	O	126	LO2	0	Power control for LCD panel.

See Table 6-10 : LCD Interface Pin Mapping for summary.

6.4 MMC/SD/SDIO Interface

Table 6-4 : MMC/SD/SDIO Interface Pin Descriptions

Pin Name	Type	LQF P Pin #	Cell	RESET# State	Description
SD_CLK	O	75	LO3	0	SD clock
SD_CMD	IO	74	LB2	-	SD command
SD_DATA[3:0]	IO	67-70	LB2	-	SD data[3:0] SD_DATA[3:1] are not used for 1 bit SD or MMC
SD_CD	I	71	LIS	-	SD card inserted
SD_WP	I	76	LIS	-	SD card write protected

6.5 Configuration

Table 6-5 : Configuration Pin Descriptions

Pin Name	Type	LQFP Pin #	Cell	RESET # State	Description
CNF[6,4:0], AD_MODE	I	77-83	LIS	—	These inputs are used to configure the SSD1926 – see Table 6-8 : Summary of Configuration pins. **Note** [1] These pins are used for configuration of the SSD1926 and must be connected directly to IOV_{DD} or V_{SS}.

6.6 Miscellaneous

Table 6-6 : Miscellaneous Pin Descriptions

Pin Name	Type	LQFP Pin #	Cell	RESET # State	Description
GPIO[4:0]	IO	88-92	LB3	0	General Purpose IO. Those GPIO signals can be programmed as LCD control which sync with LCD signals.
TESTO	O	43	LO3	0	Test output pin. Floated this pin in normal operation.

6.7 Power and Ground

Table 6-7 : Power and Ground Pin Descriptions

Pin Name	Type	LQFP Pin #	Cell	RESET # State	Description
IOV_{DD}	P	18,48, 86,108, 122	P	—	3.3V Power supply pins for I/O pads. It is recommended to place a 0.1μF bypass capacitor close to each of these pins.
IOV_{SS}	P	17,49, 87,107, 121	P	—	Ground pins for I/O pads
$COREV_{DD}$	P	5,27,39 ,56,73, 85,105, 120	P	—	1.8V Power supply pins for core. It is recommended to place a 0.1μF bypass capacitor close to each of these pins.
$COREV_{SS}$	P	6,28,38 ,55,72, 84,106, 119	P	—	Ground pins for core
PV_{DD}	P	34	P	—	1.8V Power supply pins for PLL. It is recommended to place a 0.1μF bypass capacitor close to each of these pins.
PV_{SS}	P	35	P	—	Ground pins for PLL

6.8 Summary of Configuration

These pins are used for configuration of the SSD1926 and must be connected directly to IOV_{DD} or IOV_{SS}. The state of AD_MODE, CNF[6, 4:0] is latched on the rising edge of RESET# or after the software reset function is activated (REG[A2h] bit 0). Changing state at any other time has no effect.

Table 6-8 : Summary of Configuration pins

SSD1926 Configuration Input	Power-On/Reset State	
	1 (Connected to IOV_{DD})	0 (Connected to IOV_{SS})
CNF[2:0], AD_MODE	Select host bus interface as follows: AD_MODE CNF2 CNF1 CNF0 Host Bus 0 0 1 1 Generic#1 0 1 0 0 Generic#2 1 0 1 1 Indirect 8 bit 8080 (For Big Endian only) 1 1 0 0 Indirect 16 bit 8080 **Note :** The host bus interface is 18-bit only.	
CNF3	Configure GPIO pins as inputs at power-on	Configure GPIO pins as outputs at power-on
CNF4	Big Endian bus interface	Little Endian bus interface
CNF6	MCLK = PLL_CLK / 4	MCLK = PLL_CLK
	Note : Recommended to use CNF6 = 0 for Indirect addressing mode	

6.9 Host Bus Interface Pin Mapping

Table 6-9 : Host Bus Interface Pin Mapping

SSD1926 Pin Name	Generic #1	Generic #2	Indirect 8080
AB0	Connected to IOV_{SS}	A0	Connected to IOV_{SS}
AB[18:4, 2, 1]	A[18:4, 2, 1]		Connected to IOV_{SS}
AB[3]	A[3]		D/C#
DB[15:0]	D[15:0]		D[15:0]
CS#	External Decode		
M/R#	External Decode		Connected to IOV_{SS}
CLKI2 (optional)	BUSCLK		
RD/WR#	RD1#	Connected to IOV_{DD}	Connected to V_{SS}
RD#	RD0#	RD#	RD#
WE0#	WE0#	WE#	WR#
WE1#	WE1#	BHE#	Connected to IOV_{SS}
RESET#	RESET#		

6.10 LCD Interface Pin Mapping

Table 6-10 : LCD Interface Pin Mapping

Pin Names	DUMB DRIVER										SMART DRIVER			
	Mono STN		CSTN		TFT						TFT	CSTN	OLED	TFT(Hitachi)
	4-bit	8-bit	4-bit	8-bit (format stripe)	16-bit	9-bit	12-bit	18-bit	24-bit	Serial 8 bit	8/9-bit /3 wire			
LCD_FRAME	FRAME										Drive 0	Drive 0	Drive 0	Drive 0
LCD_LINE	LINE										Drive 0	Drive 0	Drive 0	Drive 0
LCD_SHIFT	SHIFT										Drive 0	Drive 0	Drive 0	Drive 0
LCD_DEN	MOD				DEN						Drive 0	Drive 0	Drive 0	Drive 0
LCD_DATA0	Drive 0	D0	Drive 0	D0(G3)[1]	R6	R2	R3	R5	R7	D0	D0			D0/SDA
LCD_DATA1	Drive 0	D1	Drive 0	D1(R3)[1]	G5	R1	R2	R4	R6	D1	D1			
LCD_DATA2	Drive 0	D2	Drive 0	D2(B2)[1]	B4	R0	R1	R3	R5	D2	D2			
LCD_DATA3	Drive 0	D3	Drive 0	D3(G2)[1]	R4	G2	G3	G5	G7	D3	D3			
LCD_DATA4	D0	D4	D0(R2)[1]	D4(R2)[1]	B5	G1	G2	G4	G6	D4	D4			
LCD_DATA5	D1	D5	D1(B1)[1]	D5(B1)[1]	R5	G0	G1	G3	G5	D5	D5			
LCD_DATA6	D2	D6	D2(G1)[1]	D6(G1)[1]	G4	B2	B3	B5	B7	D6	D6/SCK			D6
LCD_DATA7	D3	D7	D3(R1)[1]	D7(R1)[1]	B3	B1	B2	B4	B6	D7	D7/SDA			D7
LCD_DATA8	Drive 0	Drive 0	Drive 0	Drive 0	G3	B0	B1	B3	B5	Drive 0	D8			
LCD_DATA9	Drive 0	Drive 0	Drive 0	Drive 0	B2	Drive 0	R0	R2	R4	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0
LCD_DATA10	GPIO	GPIO	GPIO	GPIO	R2	GPIO	GPIO	R1	R3	GPIO	GPIO	GPIO	GPIO	GPIO
LCD_DATA11	GPIO	GPIO	GPIO	GPIO	G1	GPIO	GPIO	R0	R2	GPIO	GPIO	GPIO	GPIO	GPIO
LCD_DATA12	GPIO	GPIO	GPIO	GPIO	R3	GPIO	G0	G2	G4	GPIO	GPIO	GPIO	GPIO	GPIO
LCD_DATA13	GPIO	GPIO	GPIO	GPIO	G2	GPIO	GPIO	G1	G3	GPIO	GPIO	GPIO	GPIO	GPIO
LCD_DATA14	GPIO	GPIO	GPIO	GPIO	B1	GPIO	GPIO	G0	G2	GPIO	GPIO	GPIO	GPIO	GPIO
LCD_DATA15	GPIO	GPIO	GPIO	GPIO	R1	GPIO	B0	B2	B4	GPIO	GPIO	GPIO	GPIO	GPIO
LCD_DATA16	GPIO	GPIO	GPIO	GPIO	GPIO	GPIO	GPIO	B1	B3	GPIO	GPIO	GPIO	GPIO	GPIO
LCD_DATA17	GPIO	GPIO	GPIO	GPIO	GPIO	GPIO	GPIO	B0	B2	GPIO	GPIO	GPIO	GPIO	GPIO
LCD_DATA18	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	R1	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0

LCD_DATA19	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	R0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0
LCD_DATA20	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	G1	Drive 0	D/C#			
LCD_DATA21	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	G0	Drive 0	CS#			
LCD_DATA22	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	B1	Drive 0	WR#;R/W#			WR#;E;SCK
LCD_DATA23	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	Drive 0	B0	Drive 0	RD#;E			RD#;R/W#

Note

(1)   These pin mappings use signal names commonly used for each panel type, however signal names may differ between panel manufacturers. The values shown in brackets represent the color components as mapped to the corresponding LCD_DATAxx signals at the first valid edge of LCD_SHIFT.

6.11 Data Bus Organization

There are two data bus architectures, little endian and big endian. Little endian means the bytes at lower addresses have lower significance. Big endian means the most significant byte has the lowest address.

Table 6-11 : Data Bus Organization

	D[15:8]	D[7:0]
Big endian	2N	2N + 1
Little endian	2N + 1	2N

Note

(1) N : Byte Address

Table 6-12 : Pin State Summary

MCU Mode (Endian)	A0	RD/WR#	RD#	WE1#	WE0#	Operation
Generic#1 (Big)	X	0	0	1	1	Word read
	X	0	1	1	1	High byte read 2N
	X	1	0	1	1	Low byte read 2N+1
	X	1	1	0	0	Word write
	X	1	1	0	1	High byte write 2N
	X	1	1	1	0	Low byte write 2N+1
Generic#1 (Little)	X	0	0	1	1	Word read
	X	0	1	1	1	High byte read 2N+1
	X	1	0	1	1	Low byte read 2N
	X	1	1	0	0	Word write
	X	1	1	0	1	High byte write 2N+1
	X	1	1	1	0	Low byte write 2N
Generic#2 (Big)	0	X	0	0	1	Word read
	0	X	0	1	1	High byte read 2N
	1	X	0	0	1	Low byte read 2N+1
	0	X	1	0	0	Word write
	0	X	1	1	0	High byte write 2N
	1	X	1	0	0	Low byte write 2N+1
Generic#2 (Little)	0	X	0	0	1	Word read
	1	X	0	0	1	High byte read 2N+1
	0	X	0	1	1	Low byte read 2N
	0	X	1	0	0	Word write
	1	X	1	0	0	High byte write 2N+1
	0	X	1	1	0	Low byte write 2N

7 FUNCTIONAL BLOCK DESCRIPTIONS

7.1 Phase Lock Loop (PLL)

The built-in PLL synthesize the internal clock by an external 2MHz – 4MHz clock through the CLKI and CLKO. RC circuit should be connected if internal PLL is selected. The input of clock source can be either oscillator or crystal. If oscillator is used, the clock source is input directly to CLKI and leave CLKO floating. The target maximum output frequency of the PLL is 85MHz. If sync MCU interface, PLL should be disabled and use direct clock input to CLKI2.
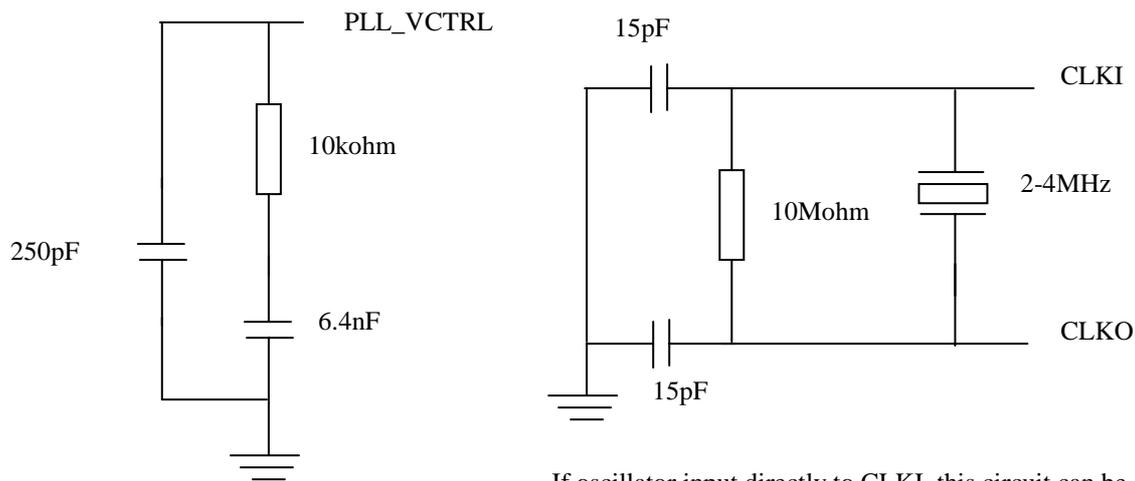
RC circuit for PLL_VCTRL

If oscillator input directly to CLKI, this circuit can be omitted

Figure 7-1 : Circuit for PLL enable

7.2 Embedded Memory

The 256kByte embedded memory can be access by the modules for different functions. For example, frame buffer, SD read/write buffer, internal buffer for JPEG encoding/decoding, encoded JPEG image output and so on.

7.3 MCU Interface

Responds to bus request for various kinds of MCU and translates to internal interface signals. SSD1926 can support direct and indirect addressing mode.

7.3.1 Generic #1 addressing Mode
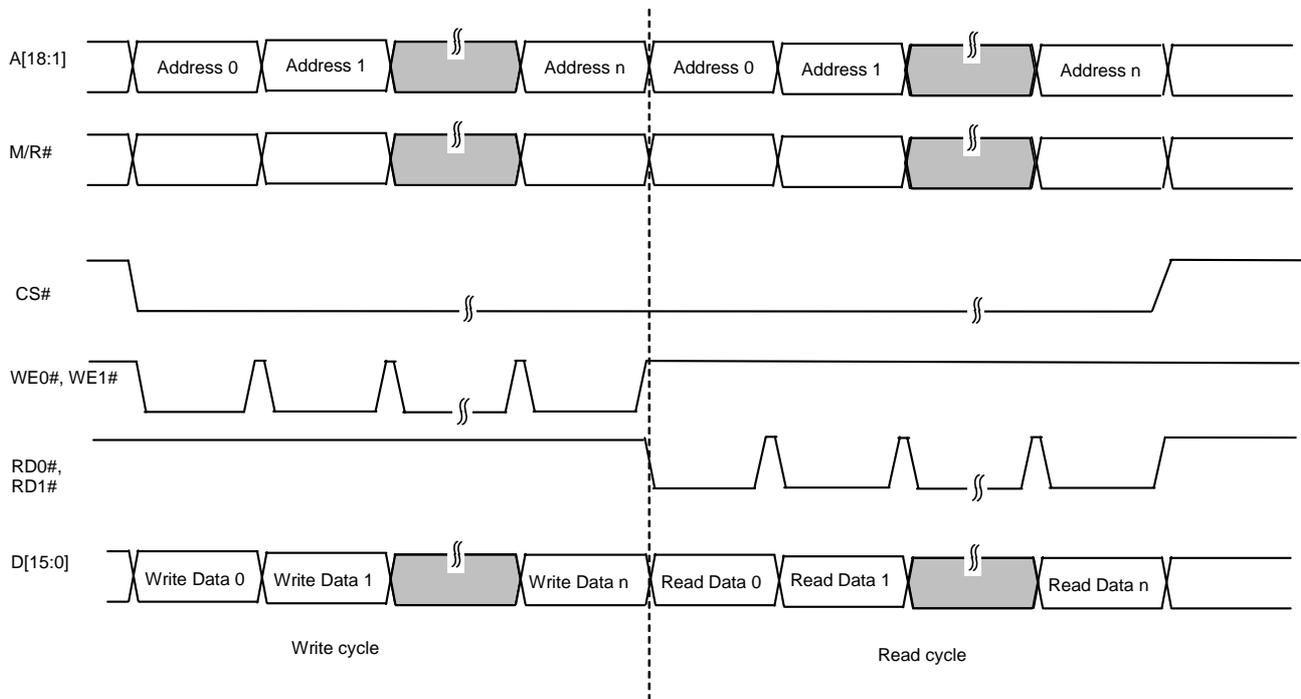
Note :

* 13 MCLK is needed for each cycle if WAIT# is not used for interface.

Figure 7-2 : Generic #1 Interface Timing

7.3.2 Generic #2 addressing Mode
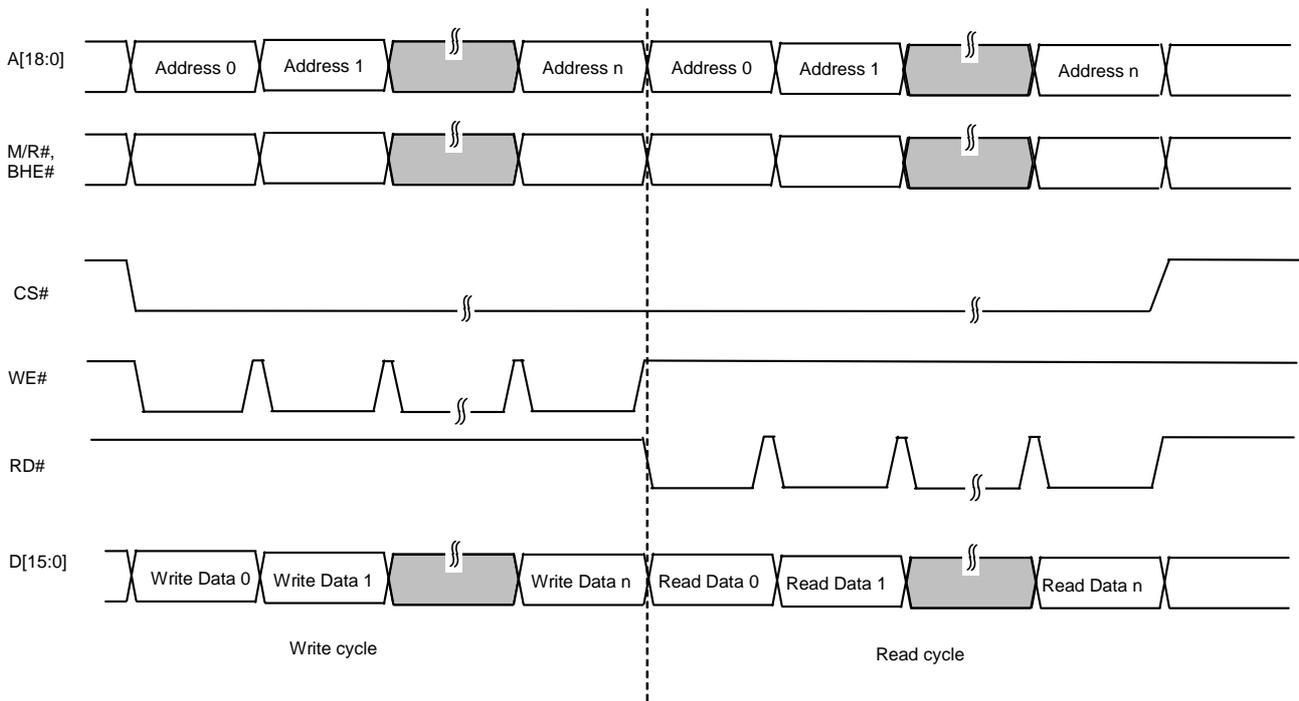
Note :

* 13 MCLK is needed for each cycle if WAIT# is not used for interface.

Figure 7-3 : Generic #2 Interface Timing

7.3.3 8080 Indirect addressing Mode

8080 Indirect addressing mode consists of 16 or 8 bi-directional data pins (DB15:0), CS#, RD#, WR# and D/C#. CS# is the chip select; RD# is the read strobe; WR# is the write strobe; and D/C# is the data/command select. They can be used for either 8 bit (DB7:0) or 16 bit (DB15:0) bus protocol. CS# failing edge input serves as data read latch signal when RD# is low. D/C# controls whether reading the data or reading the command (i.e. status). CS# failing edge input serves as data write latch signal when WR# is low. D/C# controls whether writing the data or writing the command (i.e. address). In read operation, dummy invalid data read is required after start address.

The start address counter should be assigned before the data is written or read. The most significant bit of the start address is used to select the memory or register (M/R#). During the byte mode access, the address counter is automatically incremented by 1 byte after writing or reading the data. During the word mode access, the address counter is automatically incremented by 1 word after writing or reading the data. The address counter of memory will be returned to 0x00000 if counter = 0x3FFFF in byte mode or 0x3FFFE in word mode.

For 16 bit bus protocol, it can interface with byte or word mode access. The last byte of start address in 16-bit access will be used to select byte or word mode (MODE_SL). MODE_SL = 0x00 means byte access and MODE_SL = 0x01 means word access.

Read Burst Termination must be asserted for all JPEG related memory access. If the burst length is as small as 1, the read data stage may be reduced to a single dummy read.

Refer to section 12 for Pseudo-code examples.
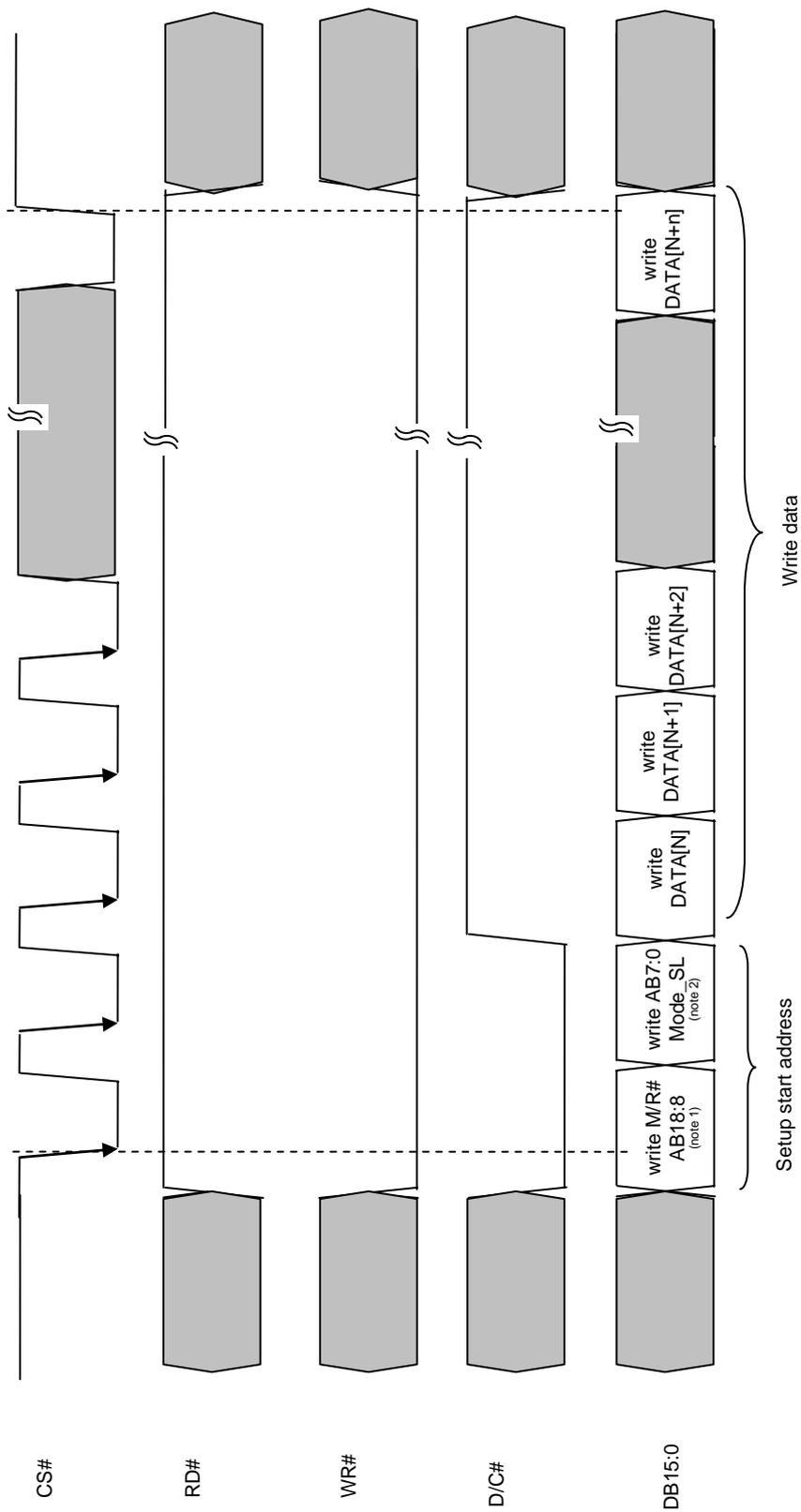
CS#
RD#
WR#
D/C#
DB15:0

write M/R# AB18:8 (note 1) | write AB7:0 Mode_SL (note 2) | write DATA[N] | write DATA[N+1] | write DATA[N+2] | write DATA[N+n]
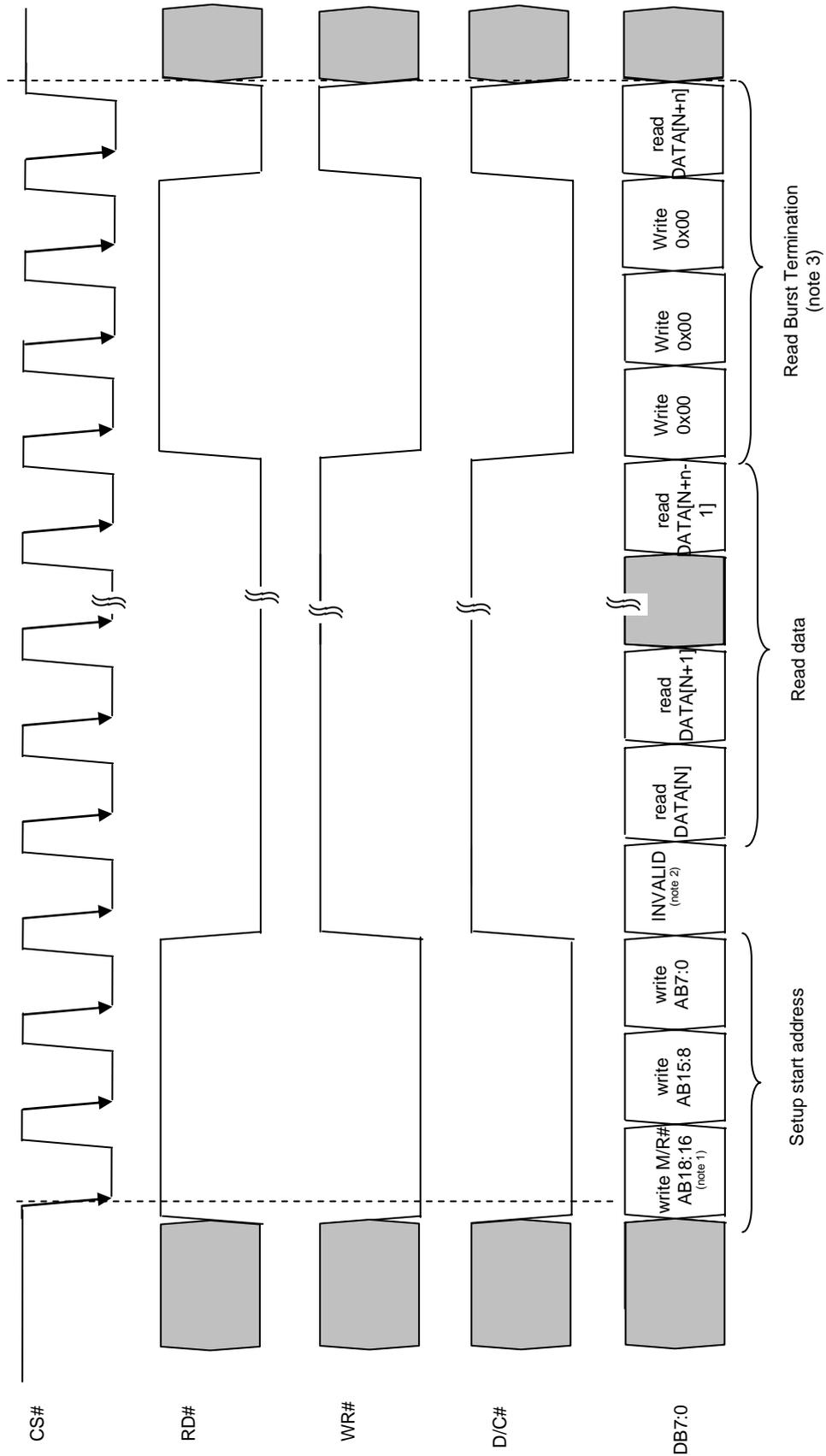
Setup start address

Write data

Note :

1 : Bit15 represent the M/R#, Bit15 = 1 means memory access, Bit15 = 0 means register access.
Bit14:11 = 0.
Bit10:0 represent the the address AB18:8.
Bit15:8 represent the address AB7:0 and Bit7:0 represent Mode_SL.

2 : Mode_SL to select byte or word access during 16 bit mode. 0x00 means Byte access, 0x01 means word access.

* 7 MCLK is needed for each cycle if WAIT# is not used for interface.

Figure 7-4 : 8080 16 bit Interface Timing (write cycle)
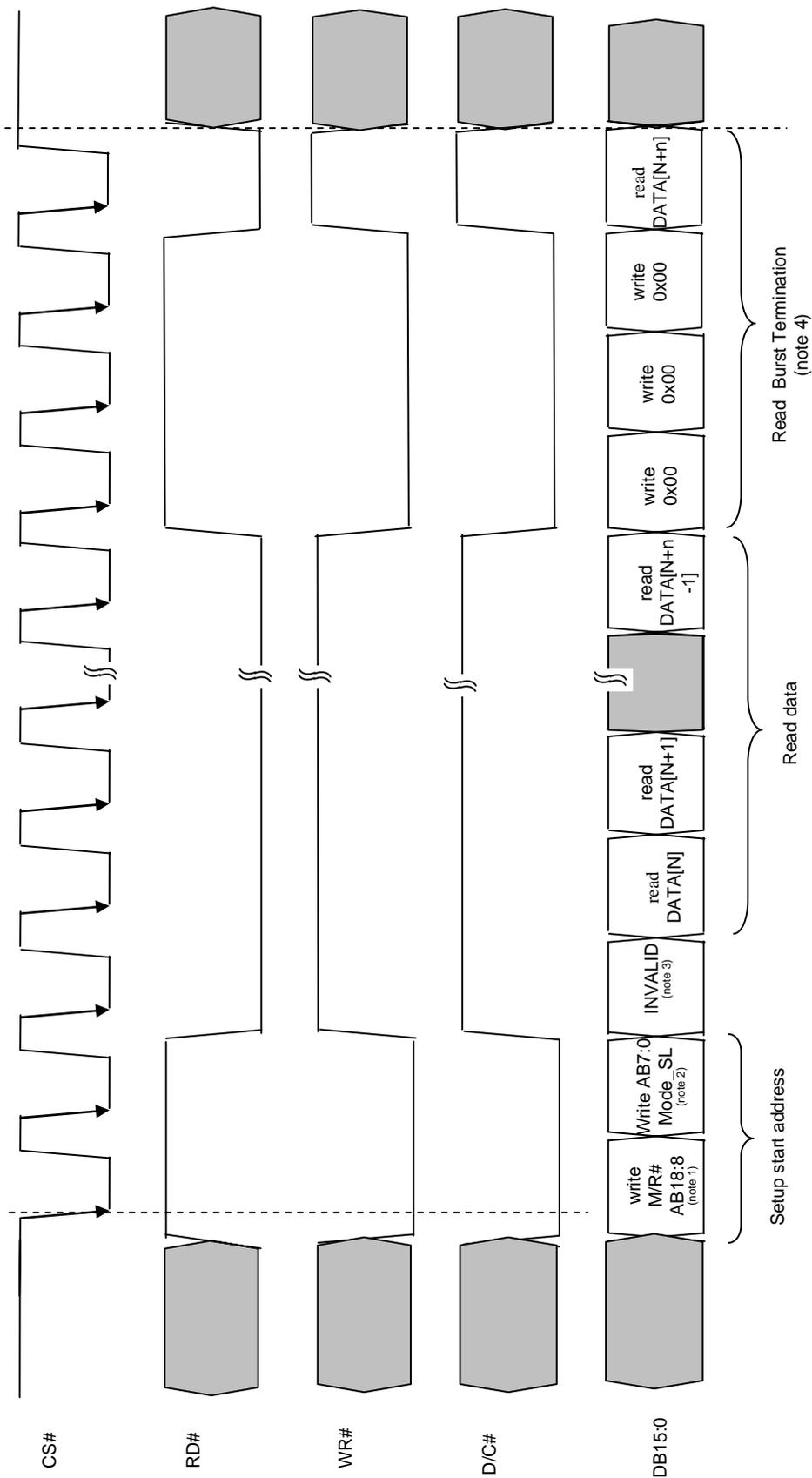
CS#

RD#

WR#

D/C#

DB15:0

write M/R# AB18:8 (note 1) | Write AB7:0 Mode_SL (note 2) | INVALID (note 3) | read DATA[N] | read DATA[N+1] | read DATA[N+n -1] | write 0x00 | write 0x00 | write 0x00 | read DATA[N+n]

Setup start address

Read data

Read Burst Termination (note 4)

Note :

1 : Bit15 represent the M/R#, Bit15 = 1 means memory access, Bit15 = 0 means register access.
Bit14:11 = 0.
Bit10:0 represent the the address AB18:8.

2 : Bit15:8 represent the address AB7:0 and Bit7:0 represent Mode_SL.
Mode_SL to select byte or word access during 16 bit mode. 0x00 means Byte access, 0x01 means word access.

3 : Invalid dummy data cycle is needed after adress is written.

4 : Read Burst Termiation must be asserted for all JPEG related memory access.

* 7 MCLK is needed for each cycle if WAIT# is not used for interface.

Figure 7-5 : 8080 16 bit Interface Timing (read cycle)
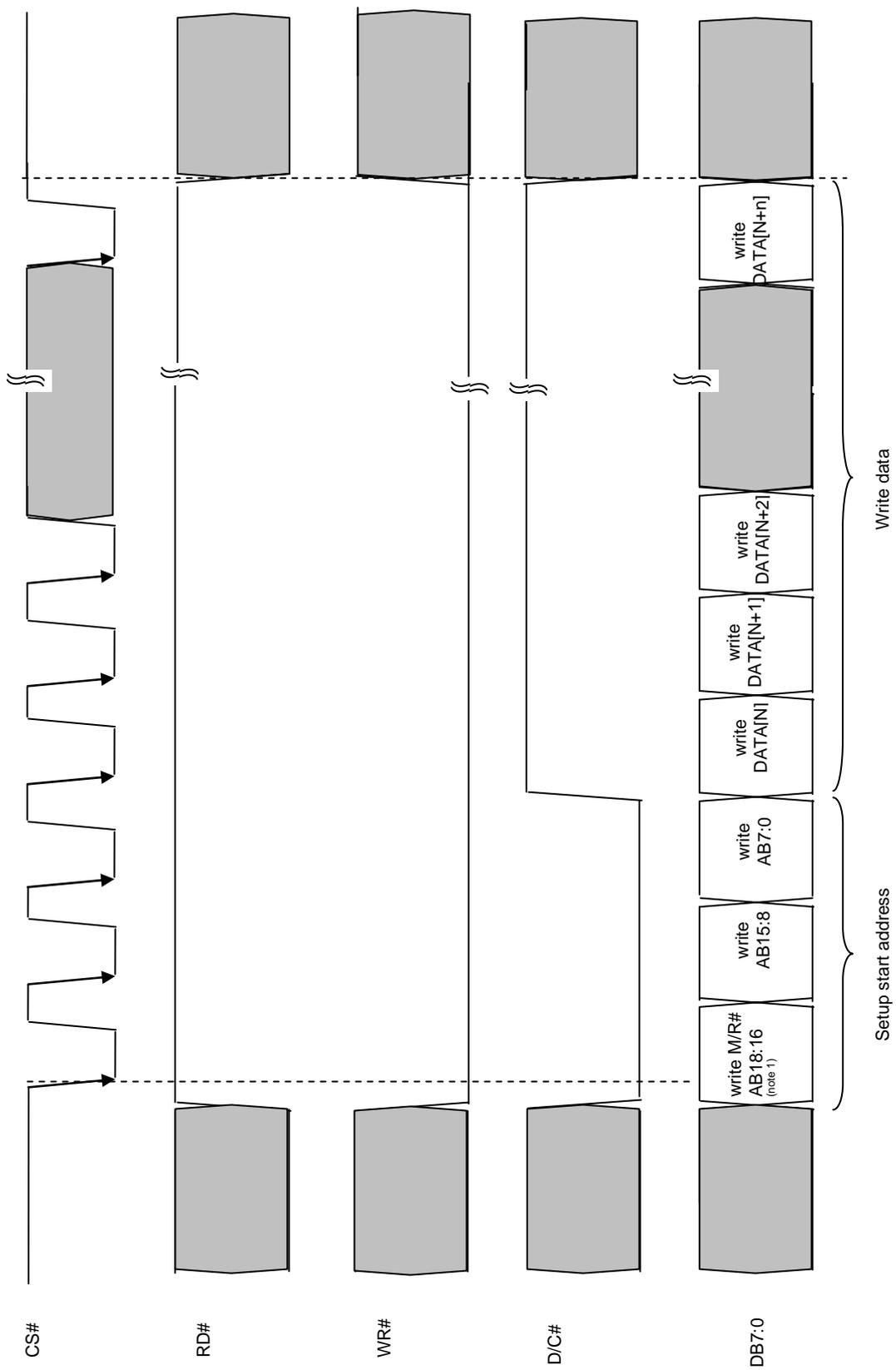
Figure 7-6 : 8080 8 bit Interface Timing (write cycle)

CS#

RD#

WR#

D/C#

DB7:0

write M/R# AB18:16 (note 1)

write AB15:8

write AB7:0

write DATA[N]

write DATA[N+1]

write DATA[N+2]

write DATA[N+n]

Setup start address

Write data

Note :

1 :   Bit7 represent the M/R#, Bit7 = 1 means memory access, Bit7 = 0 means register access.
      Bit6:3 = 0.
      Bit2:0 represent the the address AB18:16.

* 7 MCLK is needed for each cycle if WAIT# is not used for interface.

Figure 7-7 : 8080 8 bit Interface Timing (read cycle)

Note :

1 : Bit7 represent the M/R#, Bit7 = 1 means memory access, Bit7 = 0 means register access.
Bit6:3 = 0.
Bit2:0 represent the the address AB18:16.
2 : Invalid dummy read cycle is needed after address is written.
3 : Read Burst Termination must be assertesd for all JPEG relaeted memory access.

* 7 MCLK is needed for each cycle if WAIT# is not used for interface.

7.4 Registers

It stores all the register settings for different functional modules. Refer to Application Note for Register Table.

7.5 JPEG Decoder

With MMC/SD card interface, the JPEG data can be stored in external MMC/SD card. The JPEG decoder can decompress the JPEG image from embedded memory to display[1]. If the image stored in MMC/SD card is copied to embedded memory, the JPEG decoder can decompress it to display also.

Note
[1] If the output memory address is the same as the overlay window, the decompressed image will be display immediately.

7.6 2D Engine

The 2D engine is designed on the basis of Microsoft Windows GDI. It support straight line drawing, rectangle drawing, rectangle color fill, rectangle pattern fill, BitBLT, color expansion, StretchBLT and alpha blending.

7.7 Display Interface

This is LCD interface for the main display. The maximum resolution of the LCD depends on the size of frame buffer located in the embedded memory. This display interface supports most panel type, including dump STN, CSTN, TFT. The smart STN, CSTN, TFT, OLED panel of parallel and serial interface are also supported.

7.8 MMC/SD/SDIO Interface

This interface act as a bridge between the MCU and the external memory card. This interface can also used as a bridge between the internal functional blocks such as JPEG encoder/decoder and external memory card. Since this interface also supports SDIO, the MCU can use this interface as an expansion slot.

7.9 General Purpose Input/Output (GPIO)

This is a collection of 13 GPIOs with can be used for LCD, keypad, LED backlight control and so on.

8 MAXIMUM RATINGS

Table 8-1: Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
IOV_{DD}	Supply Voltage	V_{SS} - 0.3 to 4.0	V
V_{IN}	Input Voltage	V_{SS} - 0.3 to 5.0	V
V_{OUT}	Output Voltage	V_{SS} - 0.3 to IOV_{DD} + 0.5	V
T_{STG}	Storage Temperature	-65 to 150	°C
T_{SOL}	Solder Temperature/Time	260 for 10 sec. max at lead	°C

Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the limits in the Electrical Characteristics tables or Pin Description section.

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions to be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit. For proper operation it is recommended that V_{IN} and V_{OUT} be constrained to the range $V_{SS} \leq$ (V_{IN} or V_{OUT}) $\leq IOV_{DD}$. Reliability of operation is enhanced if unused input are connected to an appropriate logic voltage level (e.g., either V_{SS} or IOV_{DD}). This device is not radiation protected.

Table 8-2 : Recommended Operating Conditions

Symbol	Parameter	Condition	Min	Typ	Max	Units
IOV_{DD}	Supply Voltage	V_{SS} = 0V	3.0	3.3	3.6	V
$COREV_{DD}$	Supply Voltage	V_{SS} = 0V	1.62	1.8	1.98	V
PV_{DD}	Supply Voltage	V_{SS} = 0V	1.62	1.8	1.98	V
V_{IN}	Input Voltage		VSS		IOV_{DD}	V
T_{OPR}	Operating Temperature		-30	25	85	°C

9 DC CHARACTERISTICS

Table 9-1 : Electrical Characteristics for IOV$_{DD}$ = 3.3V typical

Symbol	Parameter	Condition	Min	Typ	Max	Units
I$_{DDS}$	Quiescent Current	Quiescent Conditions PLL_DIS = VSS			150	μA
I$_{IZ}$	Input Leakage Current		-1		1	μA
I$_{OZ}$	Output Leakage Current		-1		1	μA
V$_{OH}$	High Level Output Voltage	IOV$_{DD}$ = min I$_{OH}$ = -2mA (Type 1) -4mA (Type 2) -16mA (Type 3)	70% * IOV$_{DD}$			V
V$_{OL}$	Low Level Output Voltage	IOV$_{DD}$ = min I$_{OL}$ = 2mA (Type 1) 4mA (Type 2) 16mA (Type 3)			30% * IOV$_{DD}$	V
V$_{IH}$	High Level Input Voltage	LVTTL Level, IOV$_{DD}$ = max	90% * IOV$_{DD}$			V
V$_{IL}$	Low Level Input Voltage	LVTTL Level, IOV$_{DD}$ = min			10% * IOV$_{DD}$	V
V$_{T+}$	High Level Input Voltage	LVTTL Schmitt	1.1			V

10 AC CHARACTERISTICS

Conditions: $IOV_{DD} = 3.3V \pm 10\%$

T_A = -30°C to 85°C

T_{rise} and T_{fall} for all inputs must be < 5 ns (10% ~ 90%)

C_L = 50pF (Bus/CPU Interface)

C_L = 0pF (LCD Panel Interface)

10.1 Clock Timing

10.1.1 Input Clocks

Table 10-1 : Clock Input Requirements for CLKI

Symbol	Parameter	Min	Max	Units
F_{CLKI}	Input Clock Frequency (CLKI)	2	4	MHz
T_{CLKI}	Input Clock period (CLKI)	$1/f_{CLKI}$		ns

Table 10-2 : Oscillator Clock Input Requirements for CLKI2

Symbol	Parameter	Min	Max	Units
F_{CLKI2}	Input Clock Frequency (CLKI2)		85	MHz
T_{CLKI2}	Input Clock period (CLKI2)	$1/f_{CLKI2}$		ns

10.2 CPU Interface Timing

The following section are CPU interface AC Timing based on $IOV_{DD} = 3.3V$.

10.2.1   Generic #1 Interface Timing
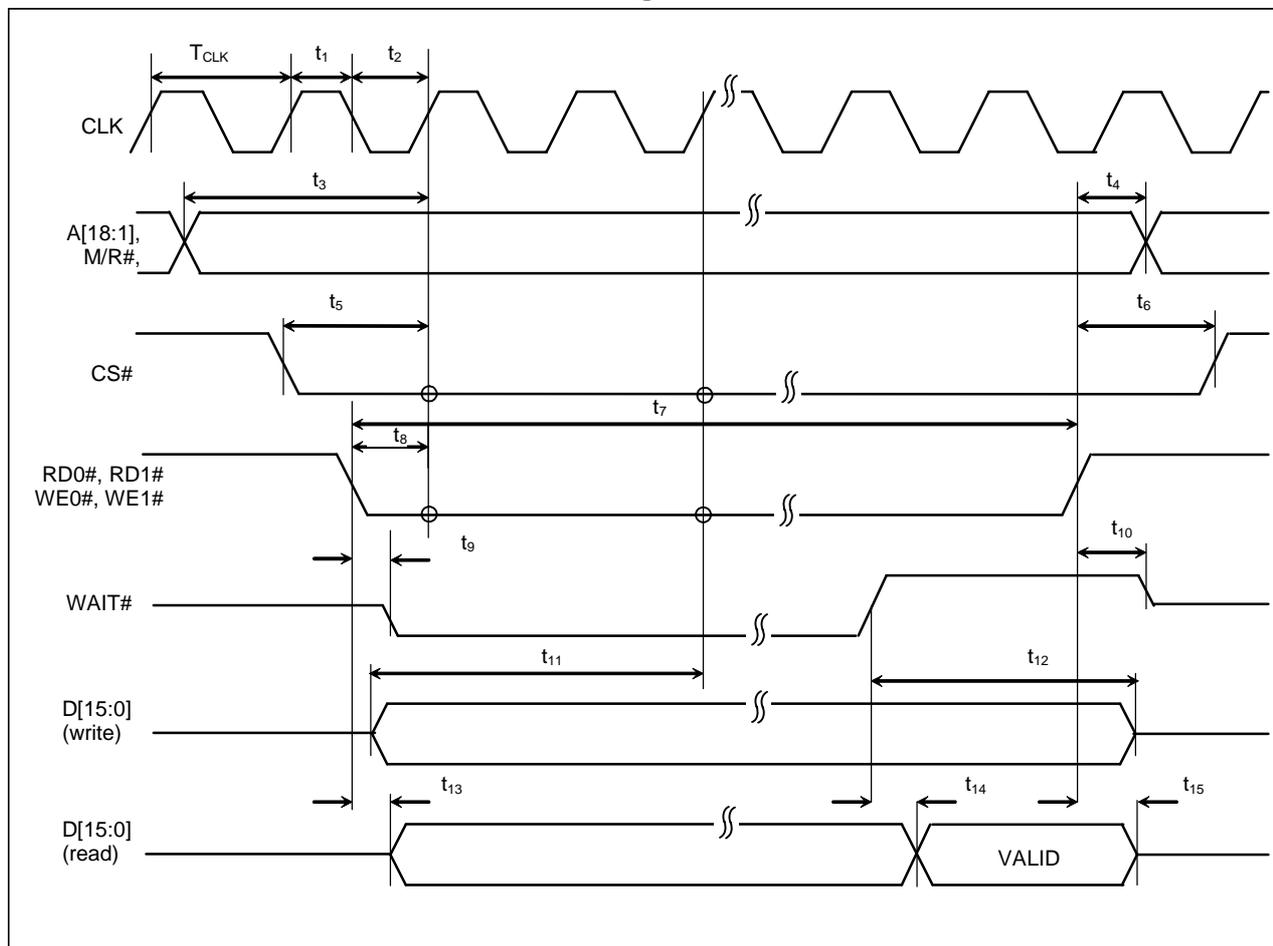
Figure 10-1 : Generic #1 Interface Timing

Table 10-3 : Generic #1 Interface Timing

Symbol	Parameter	Min	Max	Units
f_{CLK}	Bus Clock frequency		85	MHz
T_{CLK}	Bus Clock period	$1/f_{CLK}$		ns
t_1	Clock pulse width high	6		ns
t_2	Clock pulse width low	6		ns
t_3	A[18:1], M/R# setup to first CLK rising edge where CS# = 0 and either RD0#, RD1# = 0 or WE0#, WE1# = 0	1		ns
t_4	A[18:1], M/R# hold from either RD0#, RD1# or WE0#, WE1# rising edge	0		ns
t_5	CS# setup to CLK rising edge	1		ns
t_6	CS# hold from either RD0#, RD1# or WE0#, WE1# rising edge	1		ns
t_{7a}	RD0#, RD1#, WE0#, WE1# asserted for MCLK = PLL_CLK		13	T_{CLK}
t_{7b}	RD0#, RD1#, WE0#, WE1# asserted for MCLK = PLL_CLK $\div 2$		18	T_{CLK}
t_{7c}	RD0#, RD1#, WE0#, WE1# asserted for MCLK = PLL_CLK $\div 3$		23	T_{CLK}
t_{7d}	RD0#, RD1#, WE0#, WE1# asserted for MCLK = PLL_CLK $\div 4$		28	T_{CLK}
t_8	RD0#, RD1#, WE0#, WE1# setup to CLK rising edge	1		ns
t_9	Falling edge of either RD0#, RD1# or WE0#, WE1# to WAIT# driven low	3	15	ns
t_{10}	Rising edge of either RD0#, RD1# or WE0#, WE1# to WAIT# high impedance	3	13	ns
t_{11}	D[15:0] setup to third CLK rising edge where CS# = 0 and WE0#,WE1#=0 (write cycle)(see note 1)	0		ns
t_{12}	D[15:0] hold from WAIT# rising edge (write cycle)	0		ns
t_{13}	RD0#, RD1# falling edge to D[15:0] driven (read cycle)	3	14	ns
t_{14}	WAIT# rising edge to D[15:0] valid (read cycle)		2	ns
t_{15}	RD0#, RD1# rising edge to D[15:0] high impedance (read cycle)	3	11	ns

1. t_{11} is the delay from when data is placed on the bus until the data is latched into the write buffer.

## 10.2.2   Generic #2 Interface Timing (e.g. ISA)
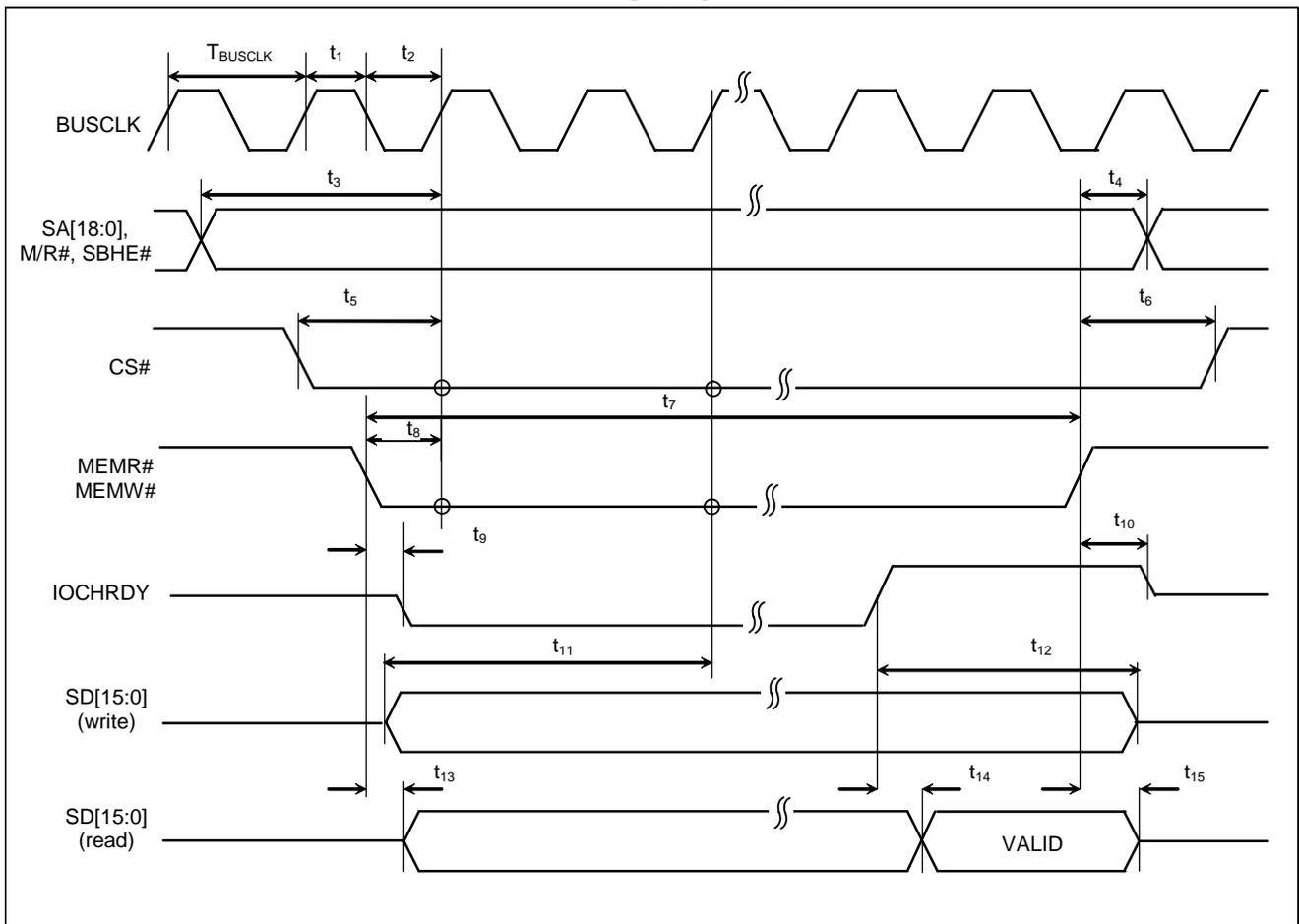
Figure 10-2 : Generic #2 Interface Timing

Table 10-4 : Generic #2 Interface Timing

Symbol	Parameter	Min	Max	Units
f_{BUSCLK}	Bus Clock frequency		85	MHz
T_{BUSCLK}	Bus Clock period	$1/f_{BUSCLK}$		ns
t_1	Clock pulse width high	6		ns
t_2	Clock pulse width low	6		ns
t_3	SA[18:0], M/R#, SBHE# setup to first BUSCLK rising edge where CS# = 0 and either MEMR# = 0 or MEMW# = 0	1		ns
t_4	SA[18:0], M/R#, SBHE# hold from either MEMR# or MEMW# rising edge	0		ns
t_5	CS# setup to BUSCLK rising edge	1		ns
t_6	CS# hold from either MEMR# or MEMW# rising edge	0		ns
t_{7a}	MEMR# or MEMW# asserted for MCLK = PLL_CLK		13	T_{BUSCLK}
t_{7b}	MEMR# or MEMW# asserted for MCLK = PLL_CLK ÷2		18	T_{BUSCLK}
t_{7c}	MEMR# or MEMW# asserted for MCLK = PLL_CLK ÷3		23	T_{BUSCLK}
t_{7d}	MEMR# or MEMW# asserted for MCLK = PLL_CLK ÷4		28	T_{BUSCLK}
t_8	MEMR# or MEMW# setup to BUSCLK rising edge	1		ns
t_9	Falling edge of either MEMR# or MEMW# to IOCHRDY driven low	3	15	ns
t_{10}	Rising edge of either MEMR# or MEMW# to IOCHRDY high impedance	3	13	ns
t_{11}	SD[15:0] setup to third BUSCLK rising edge where CS# = 0 and MEMW#=0 (write cycle)(see note1)	0		ns
t_{12}	SD[15:0] hold from IOCHRDY rising edge (write cycle)	0		ns
t_{13}	MEMR# falling edge to SD[15:0] driven (read cycle)	3	13	ns
t_{14}	IOCHRDY rising edge to SD[15:0] valid (read cycle)		2	ns
t_{15}	Rising edge of MEMR# to SD[15:0] high impedance (read cycle)	3	12	ns

1. t_{11} is the delay from when data is placed on the bus until the data is latched into the write buffer.

10.2.3 8080 Indirect Interface Timing
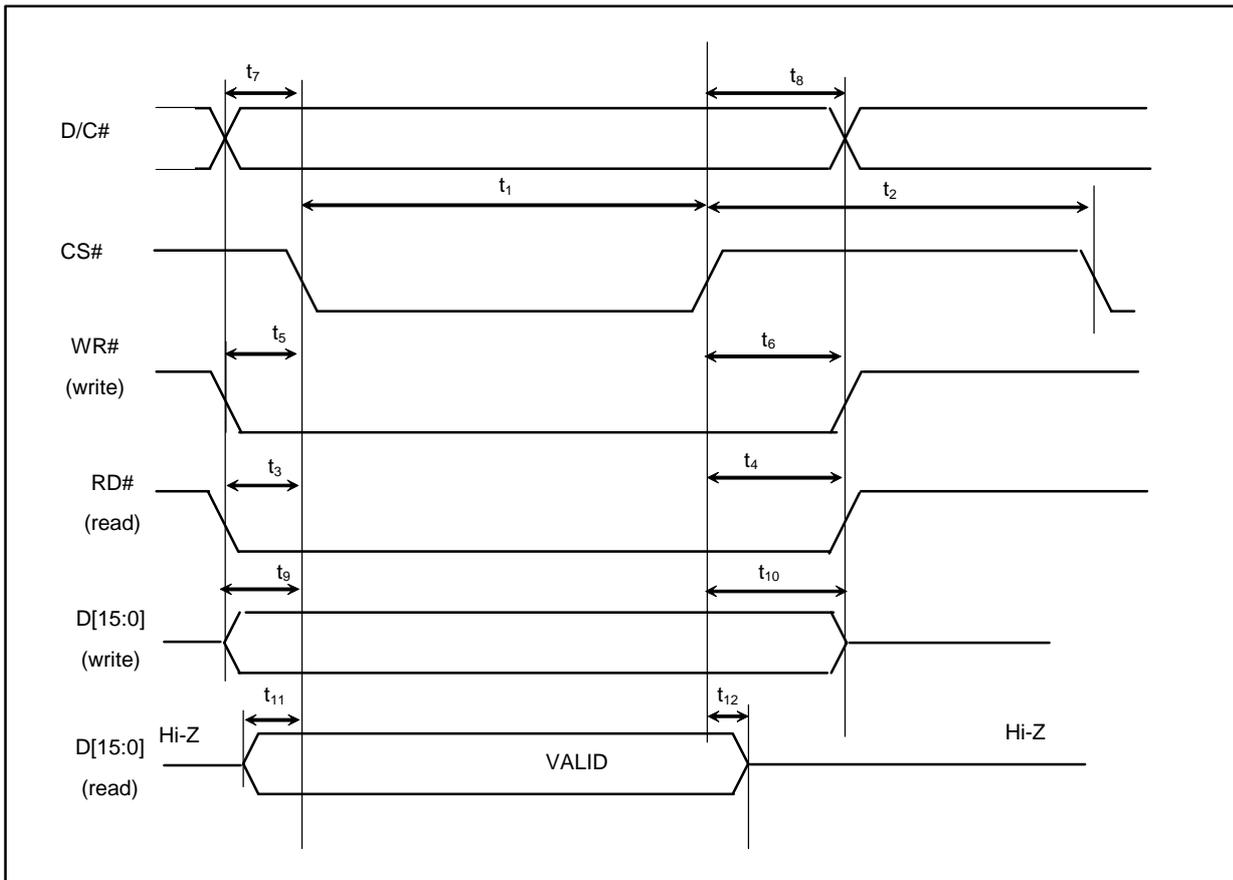
Figure 10-3 : 8080 Interface Timing

Table 10-5 : 8080 Interface Timing

Symbol	Parameter	Min	Max	Units
t_1	CS# pulse width low	82		ns
t_2	CS# pulse width high	82		ns
t_3	RD# setup	18		ns
t_4	RD# hold	0		ns
t_5	WR# setup	18		ns
t_6	WR# hold	0		ns
t_7	D/C# setup	18		ns
t_8	D/C# hold	0		ns
t_9	D[15:0] setup for write	18		ns
t_{10}	D[15:0] hold for write	0		ns
t_{11}	D[15:0] delay for read	55		ns
t_{12}	D[15:0] hold for read	0		ns

Note : Above timing is based on MCLK = 85MHz

11   APPLICATION EXAMPLES

11.1 Application Diagram

Figure 11-1 : Typical System Diagram (Generic #1 Bus)
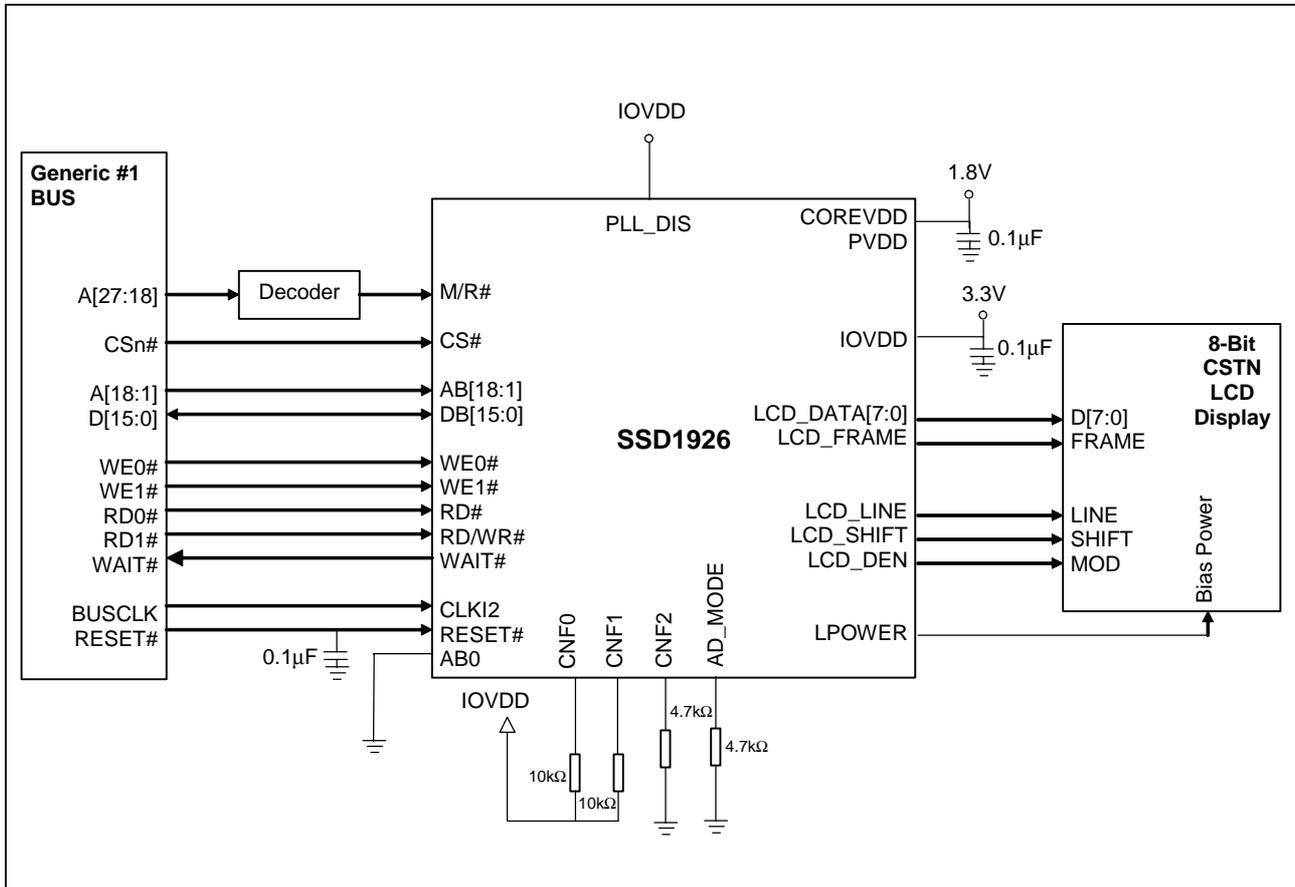
Figure 11-2 : Typical System Diagram (Generic #2 Bus)
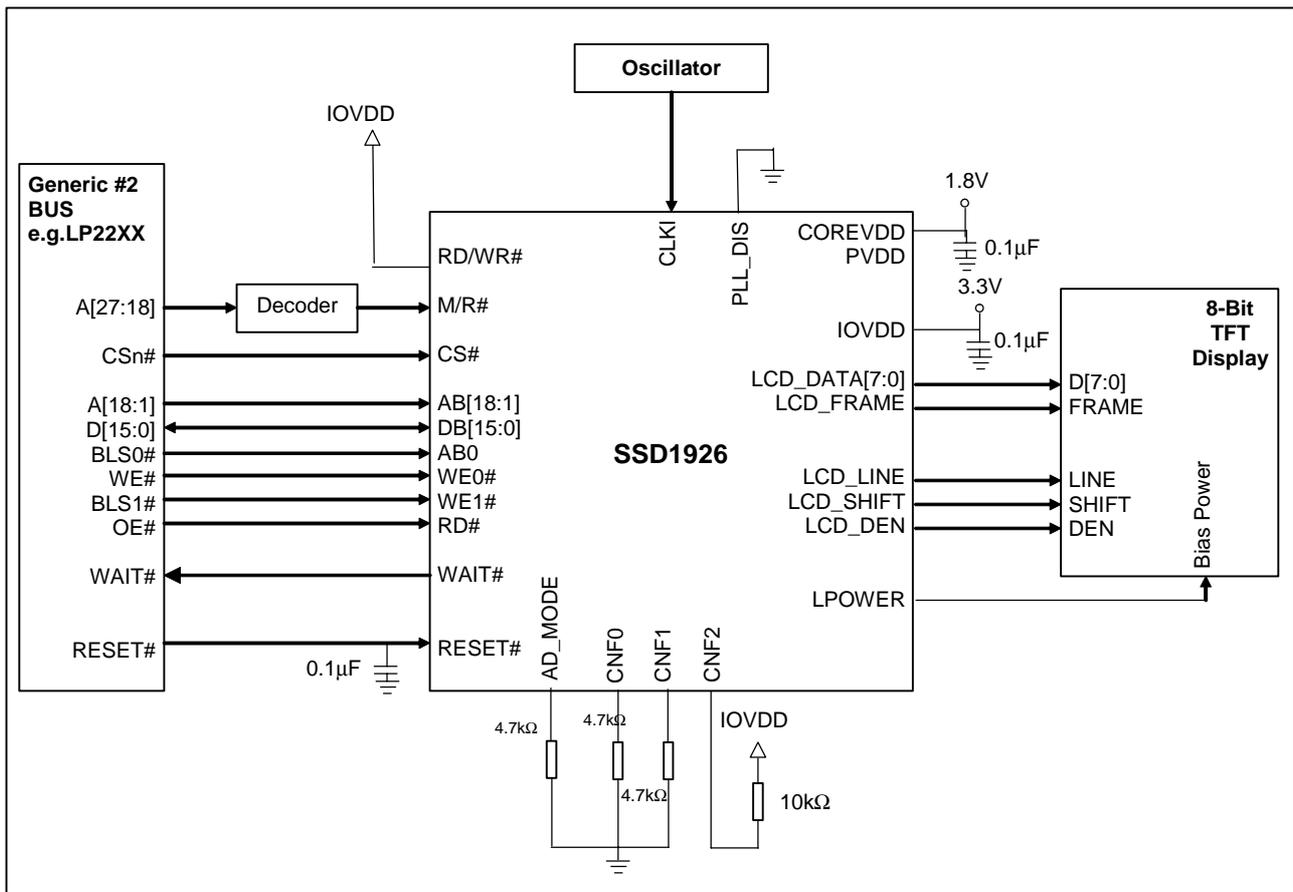
Figure 11-3 : Typical System Diagram (Indirect 8080 16 bit Bus)
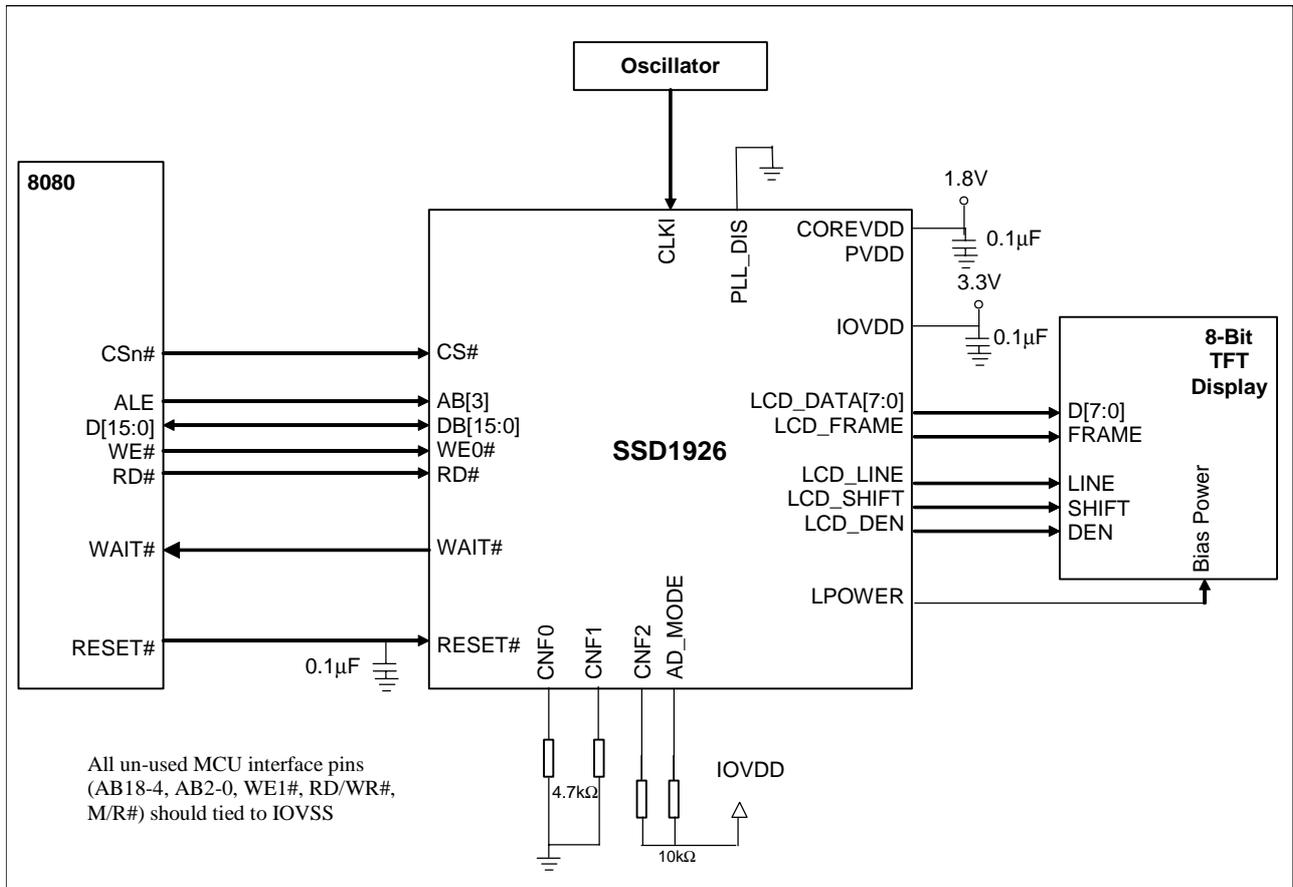
Figure 11-4: Typical System Diagram (Generic #2 Bus)
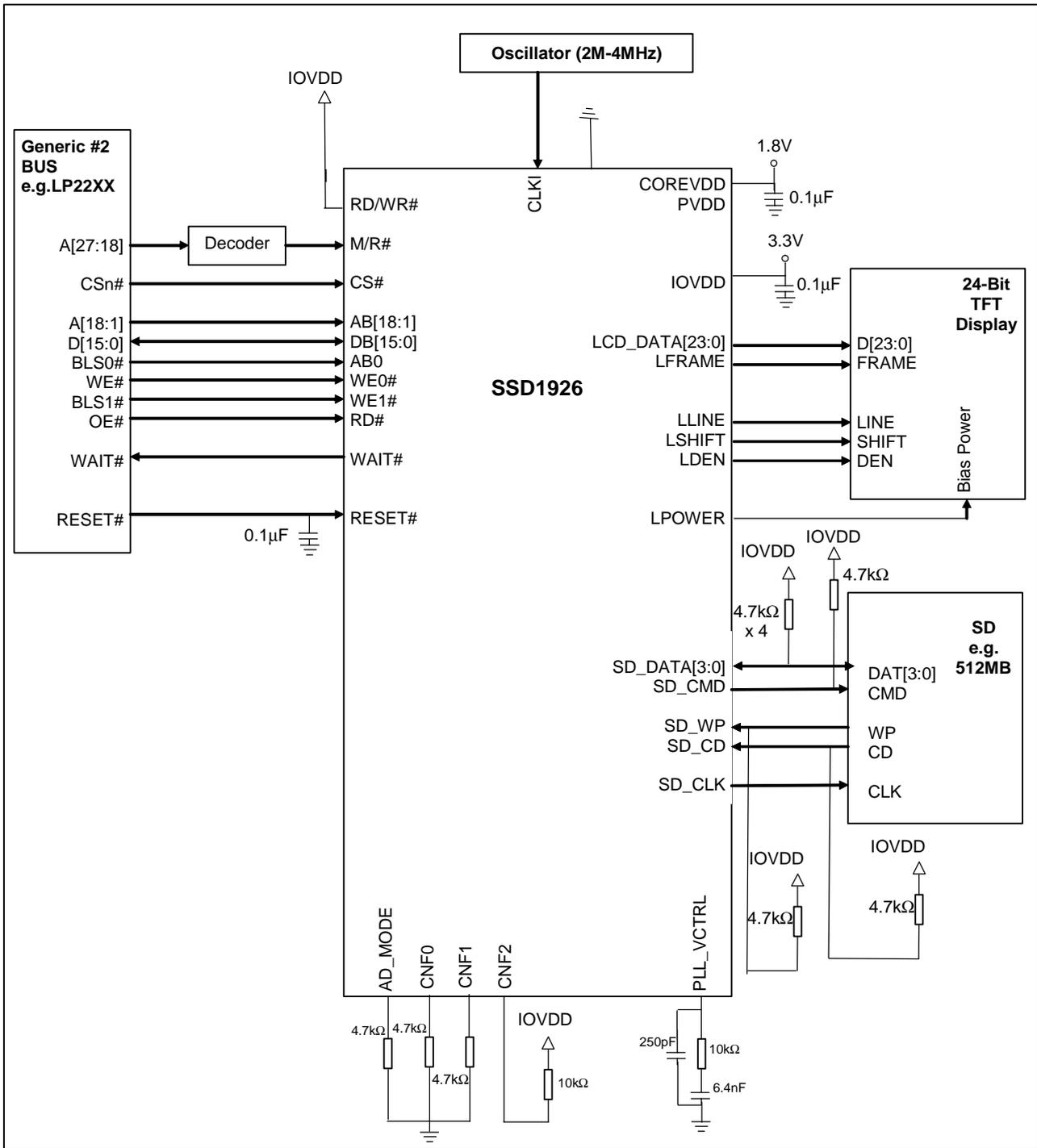
12 Pseudo-code Examples for Indirect address mode

12.1 8080 Indirect address mode

For example, PORTA is used for control signals and PORTB is used for data signals.

PORTA[3:0] are the control signals

PORTA[7]	PORTA[6]	PORTA[5]	PORTA[4]	PORTA[3]	PORTA[2]	PORTA[1]	PORTA[0]
X	X	X	X	CS#	RD#	WR#	D/C#

X : Don't care

PORTB[15:0] are the data signals for 16 bit mode
PORTB[7:0] are the data signals for 8 bit mode

```
read_command (cmd)
        write PORTA, 0x0A          [CS#=1, RD#=0, WR#=1, D/C#=0]
        write PORTA, 0x02          [CS#=0, RD#=0, WR#=1, D/C#=0]
        read PORTB, cmd
        write PORTA, 0x0E          [CS#=1, RD#=1, WR#=1, D/C#=0]

read_data (data)
        write PORTA, 0x0B          [CS#=1, RD#=0, WR#=1, D/C#=1]
        write PORTA, 0x03          [CS#=0, RD#=0, WR#=1, D/C#=1]
        read PORTB, data
        write PORTA, 0x0F          [CS#=1, RD#=1, WR#=1, D/C#=1]

write_command (cmd)
        write PORTB, cmd
        write PORTA, 0x0C          [CS#=1, RD#=1, WR#=0, D/C#=0]
        write PORTA, 0x04          [CS#=0, RD#=1, WR#=0, D/C#=0]
        write PORTA, 0x0E          [CS#=1, RD#=1, WR#=1, D/C#=0]

write_data (data)
        write PORTB, data
        write PORTA, 0x0D          [CS#=1, RD#=1, WR#=0, D/C#=1]
        write PORTA, 0x05          [CS#=0, RD#=1, WR#=0, D/C#=1]
        write PORTA, 0x0F          [CS#=1, RD#=1, WR#=1, D/C#=1]
```

Example 1 : Register Access with 16 bit indirect address mode (Big Endian, CNF4=1) with Word Mode

(Write **Register** REG[0x010h]=0x11, REG[0x011h]=0x22, REG[0x012h]=0x33, REG[0x013h]=0x04 and read back the contents)

Step 1: Set the start address to 0x00010 and write DATA0
    write_command 0x0000   [M/R#=0 => Register]
    write_command 0x1001   [start address = 0x00010, MODE_SL=0x01 => Word]
    write_data 0x1122   [write word 0x1122 to REG[0x010]]
Step 2 : Write DATA1
    write_data 0x3304   [write word 0x3304 to REG[0x012]]
Step 3 : Set the start Address to 0x00010 and dummy read
    write_command 0x0000   [M/R#=0 => Register]
    write_command 0x1001   [start address = 0x00010,MODE_SL=0x01 => Word]
    read_data DUMMY   [first read cycle is dummy]
Step 4 : Read Back the Data [Total = 4 bytes]
    read_data DATA0   [read back value is 0x1122 => REG[0x010]=0x1122]
    read_data DATA1   [read back value is 0x3304 => REG[0x012]=0x3304]

Example 2 : Register Access with 16 bit indirect address mode (Big Endian, CNF4=1) with Byte Mode

(Write **Register** REG[0x010h]=0x11, REG[0x011h]=0x22, REG[0x012h]=0x33, REG[0x013h]=0x04 and read back the contents)

Step 1: Set the start address to 0x00010 and write DATA0
    write_command 0x0000   [M/R#=0 => Register]
    write_command 0x1000   [start address = 0x00010, MODE_SL=0x00 => Byte]
    write_data 0x1122   [write word 0x11 to REG[0x010]]
Step 2 : Write the DATA1-3
    write_data 0x3344   [write word 0x44 to REG[0x011]]
    write_data 0xAABB   [write word 0xAA to REG[0x012]]
    write_data 0xCC07   [write word 0x07 to REG[0x013]]
Step 3 : Set the start Address to 0x00010 and dummy read
    write_command 0x0000   [M/R#=0 => Register]
    write_command 0x1000   [start address = 0x00010,MODE_SL=0x00 => Byte]
    read_data DUMMY   [first read cycle is dummy]
Step 4 : Read Back the Data [Total = 4 bytes]
    read_data DATA0   [read back value is 0x1144 => REG[0x010]=0x11]
    read_data DATA1   [read back value is 0x1144 => REG[0x011]=0x44]
    read_data DATA2   [read back value is 0xAA07 => REG[0x012]=0xAA]
    read_data DATA3   [read back value is 0xAA07 => REG[0x013]=0x07]

Example 3 : Memory Access with 16 bit indirect address mode (Big Endian, CNF4=1) with Word Mode

(Write **Memory** AB[0x00910h]=0x11, AB[0x00911h]=0x22, AB[0x00912h]=0x33, AB[0x00913h]=0x44 and read back the contents)

Step 1: Set the start address to 0x00910 and write DATA0
        write_command 0x8009   [M/R#=1 => Memory]
        write_command 0x1001   [start address = 0x00910, MODE_SL=0x01 => Word]
        write_data 0x1122   [write word 0x1122 to 0x00910]
Step 2 : Write the DATA1
        write_data 0x3344   [write word 0x3344 to 0x00912]
Step 3 : Set the start Address to 0x00910 and dummy read
        write_command 0x8009   [M/R#=1 => Memory]
        write_command 0x1001   [start address = 0x00910,MODE_SL=0x01 => Word]
        read_data DUMMY   [first read cycle is dummy]
Step 4 : Read Back the Data [Total = 4 bytes]
        read_data DATA0   [read back value is 0x1122 => AB[0x00910]=0x1122]
        read_data DATA1   [read back value is 0x3344 => AB[0x00912]=0x3344]

Example 4 : Memory Access with 16 bit indirect address mode (Big Endian, CNF4=1) with Byte Mode

(Write **Memory** AB[0x00910h]=0x11, AB[0x00911h]=0x22, AB[0x00912h]=0x33, AB[0x00913h]=0x44 and read back the contents)

Step 1: Set the start address to 0x00910 and write DATA0
        write_command 0x8009   [M/R#=1 => Memory]
        write_command 0x1000   [start address = 0x00910, MODE_SL=0x00 => Byte]
        write_data 0x1122   [write word 0x11 to AB[0x00910]]
Step 2 : Write the DATA1-3
        write_data 0x3344   [write word 0x44 to AB[0x00911]]
        write_data 0xAABB   [write word 0xAA to AB[0x00912]]
        write_data 0xCCDD   [write word 0xDD to AB[0x00913]]
Step 3 : Set the start Address to 0x00910 and dummy read
        write_command 0x8009   [M/R#=1 => Memory]
        write_command 0x1000   [start address = 0x00910,MODE_SL=0x00 => Byte]
        read_data DUMMY   [first read cycle is dummy]
Step 4 : Read Back the Data [Total = 4 bytes]
        read_data DATA0   [read back value is 0x1144 => AB[0x00910]=0x11]
        read_data DATA1   [read back value is 0x1144 => AB[0x00911]=0x44]
        read_data DATA2   [read back value is 0xAADD => AB[0x00912]=0xAA]
        read_data DATA3   [read back value is 0xAADD => AB[0x00913]=0xDD]

Example 5 : Register Access with 8 bit indirect address mode (Big Endian, CNF4=1)

(Write **Register** REG[0x010h]=0x11, REG[0x011h]=0x22, REG[0x012h]=0x33, REG[0x013h]=0x04 and read back the contents)

Step 1: Set the start address to 0x00010 and write DATA0
      write_command 0x00   [M/R#=0 => Register]
      write_command 0x00
      write_command 0x10   [start address = 0x00010]
   write_data 0x11   [write word 0x11 to REG[0x010]]
Step 2 : Write the DATA1-3
      write_data 0x22   [write word 0x22 to REG[0x011]]
      write_data 0x33   [write word 0x33 to REG[0x012]]
      write_data 0x04   [write word 0x04 to REG[0x013]]
Step 3 : Set the start Address to 0x00010 and dummy read
      write_command 0x00   [M/R#=0 => Register]
      write_command 0x00
      write_command 0x10   [start address = 0x00010]
      read_data DUMMY   [first read cycle is dummy]
Step 4 : Read Back the Data [Total = 4 bytes]
      read_data DATA0   [read back value is 0x11 => REG[0x010]=0x11]
      read_data DATA1   [read back value is 0x22 => REG[0x011]=0x22]
      read_data DATA2   [read back value is 0x33 => REG[0x012]=0x33]
      read_data DATA3   [read back value is 0x04 => REG[0x013]=0x04]

Example 6 : Memory Access with 8 bit indirect address mode (Big Endian, CNF4=1)

(Write **Memory** AB[0x00910h]=0x11, AB[0x00911h]=0x22, AB[0x00912h]=0x33, AB[0x00913h]=0x44 and read back the contents)

Step 1: Set the start address to 0x00910 and write DATA0
      write_command 0x80   [M/R#=1 => Memory]
      write_command 0x09
      write_command 0x10   [start address = 0x00910]
      write_data 0x11   [write word 0x11 to AB[0x00910]]
Step 2 : Write the DATA1-3
      write_data 0x22   [write word 0x22 to AB[0x00911]]
      write_data 0x33   [write word 0x33 to AB[0x00912]]
      write_data 0x44   [write word 0x44 to AB[0x00913]]
Step 3 : Set the start Address to 0x00910 and dummy read
      write_command 0x80   [M/R#=1 => Memory]
      write_command 0x09
      write_command 0x10   [start address = 0x00910]
      read_data DUMMY   [first read cycle is dummy]
Step 4 : Read Back the Data [Total = 4 bytes]
      read_data DATA0   [read back value is 0x11 => AB[0x00910]=0x11]
      read_data DATA1   [read back value is 0x22 => AB[0x00911]=0x22]
      read_data DATA2   [read back value is 0x33 => AB[0x00912]=0x33]
      read_data DATA3   [read back value is 0x44 => AB[0x00913]=0x44]

13 PACKAGE INFORMATION

13.1 Package Mechanical Drawing for 128 pins LQFP
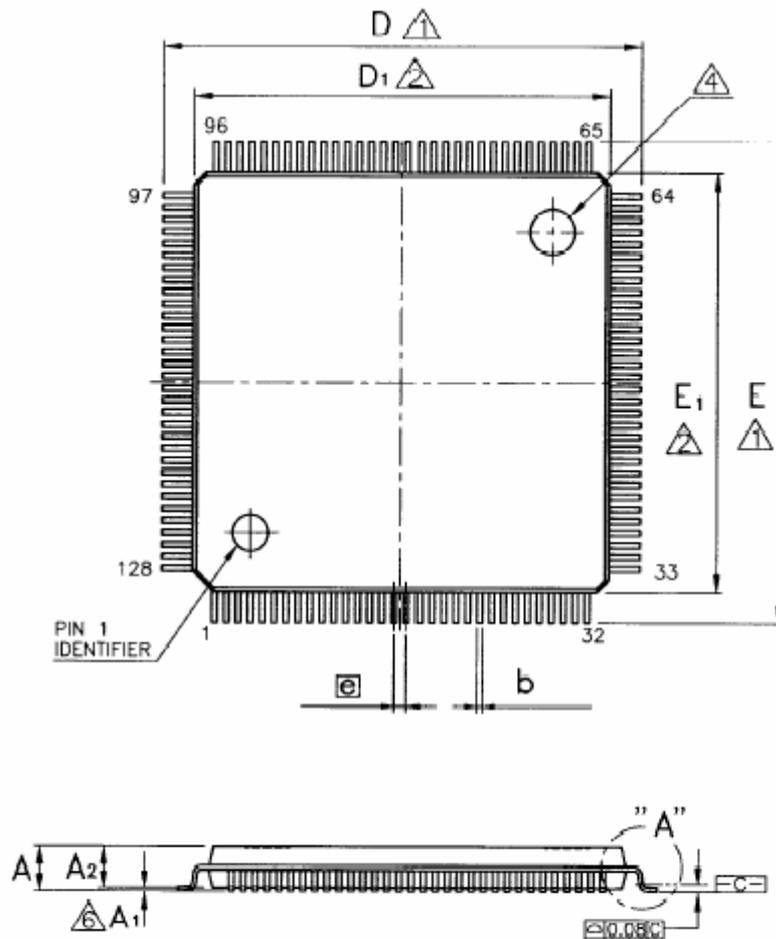
Symbol	Dimension in mm		
	Min	Nom	Max
A			1.60
A1	0.05		
A2		1.40	
D		16.00	
D1		14.00	
E		16.00	
E1		14.00	
e	0.40 BSC		
b		0.18	

All Solomon Systech Products complied with six (6) hazardous substances limitation requirement per European Union (EU) "Restriction of Hazardous Substance (RoHS) Directive (2002/95/EC)" and China standard "电子信息产品污染控制标识要求 (SJ/T11364-2006)" with control Marking Symbol . Hazardous Substances test report is available upon requested.

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